

III-V Nano-Ridge Lasers Integrated on Silicon

Dries Van Thourhout

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Motivation

It's all about light, so we need a laser source !

- Main driver: interconnect for AI engines
- Different options
 - Off-chip, separate from the core optical interconnect
 - Option 1: high-power, stand alone
 - Option 2: multi-wavelength laser modules with additional components
 - On-chip
 - Probably challenging when densely integrated with electronics (temperature)
 - Relevant for other types of applications (e.g. cheap optical sensors)

NVIDIA and Coherent Announce Strategic Partnership to Develop Optics Technology to Scale Next-Generation Data Center Architecture

NVIDIA to Invest \$2 Billion in Coherent to Expand Supply, Deepen R&D and Advance US-Based Manufacturing

NVIDIA Announces Strategic Partnership With Lumentum to Develop State-of-the-Art Optics Technology

March 2, 2026

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NVIDIA to Invest \$2 Billion in Lumentum to Grow Capacity, Advance US-Based Manufacturing and Deepen R&D Collaboration in Data Center Optics

Related CLEO talks:

STU2G.1. [Invited Talk] Perspectives on Heterogeneous Laser Integration in Silicon Photonics [*Roel Baets*](#)

AM4B.1. [Invited Talk] Scaling Lasers to Support High Bandwidth Silicon Photonics [*Jessie Rosenberg*](#)

Integration

Silicon Photonics has no native laser source, so we need heterogeneous integration

- Many integration approaches based on layer transfer are being explored
 - Flip-chip, wafer-bonding, die-to-wafer bonding, microtransfer printing...
 - Allow for transfer of pristine layers, different materials (= different wavelengths), versatile
- Hetero-epitaxy is an alternative but challenging
 - **Lattice** mismatch, mismatch in **thermal** expansion coefficient, mismatch in **polarity**
 - Every material needs separate development
- So why ?
 - Ultimate scalability
 - Designer no longer has to worry about integration approach
 - Think Ge detector vs. III-V detector

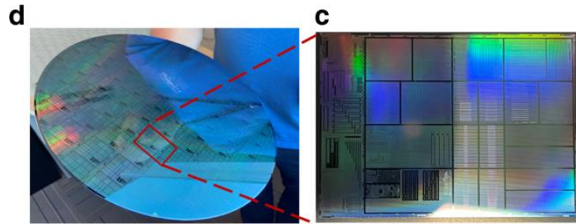
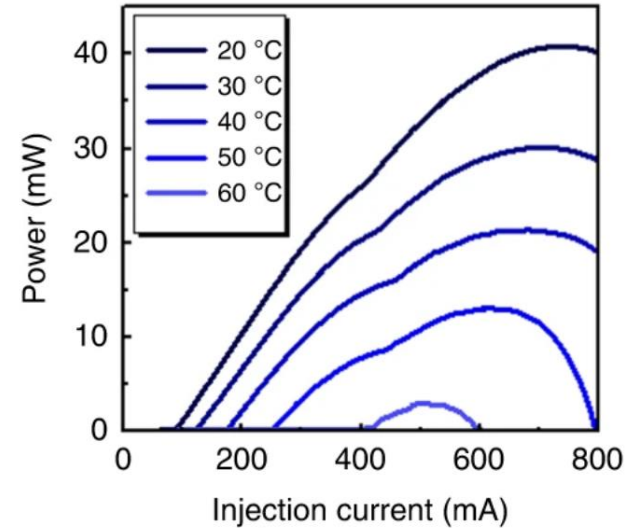
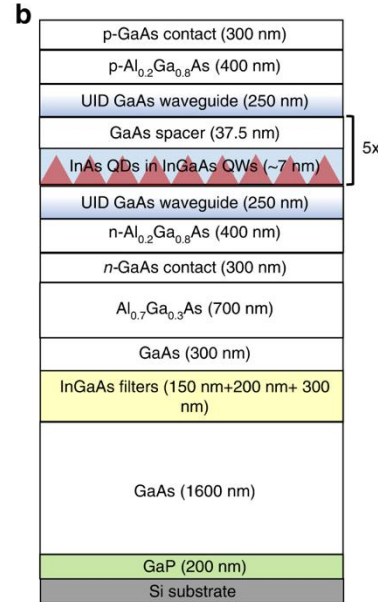
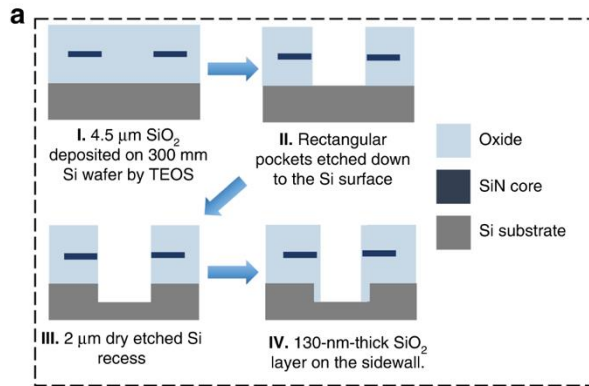
Approaches for Hetero-Epitaxy

Planar growth vs. localised growth

Approaches for Hetero-Epitaxy

Planar growth vs. localised growth

- A buffer layer grown on the silicon substrate accommodates for the mismatch in materials

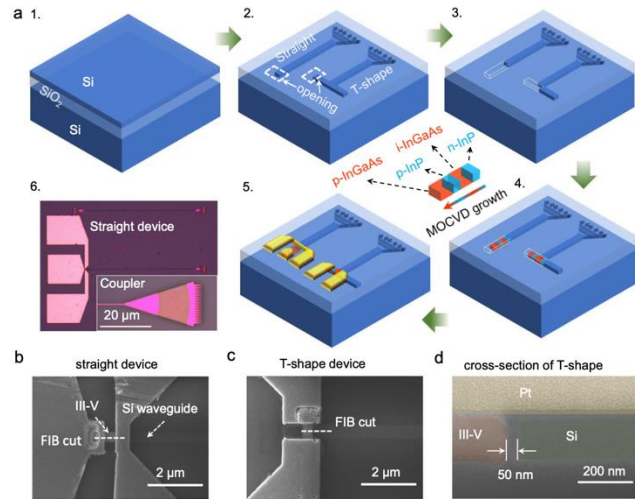


Approaches for Hetero-Epitaxy

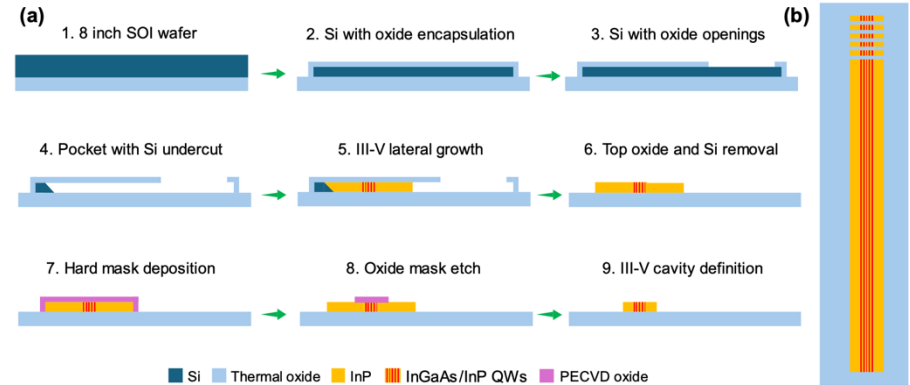
Planar growth vs. localised growth

Growing in a confined space suppresses defects

IBM - Template Assisted Growth



HKUST - Lateral MOCVD



Wen, P., Tiwari, P., Mauthe, S. *et al.* Waveguide coupled III-V photodiodes monolithically integrated on Si. *Nat Commun* **13**, 909 (2022).

<https://doi.org/10.1038/s41467-022-28502-6>

Y.Xue, J.Li, Y.Wang, K.Xu, Z.Xing, K. S.Wong, H. K.Tsang, K. M.Lau, In-Plane 1.5 μm Distributed Feedback Lasers Selectively Grown on (001) SOI. *Laser Photonics Rev*2024, 18, 2300549. <https://doi.org/10.1002/lpor.202300549>

Our Approach

Aspect Ratio Trapping (ART) combined with Nano-Ridge Engineering (NRE)

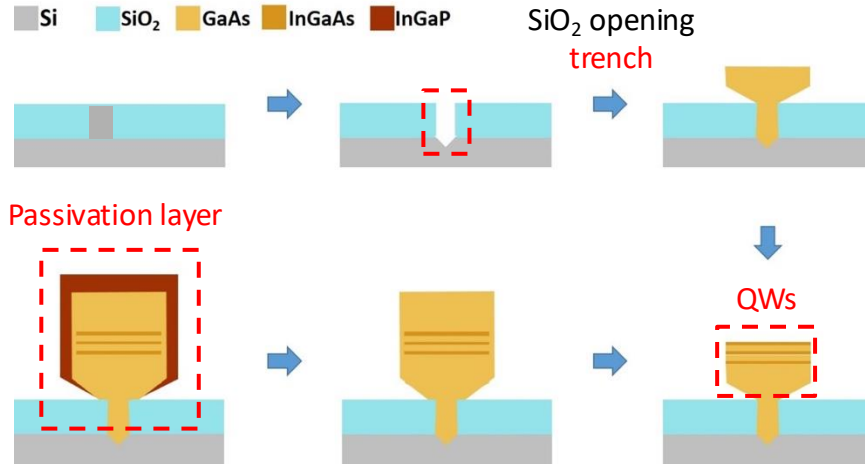
■ Si ■ SiO₂ ■ GaAs ■ InGaAs ■ InGaP



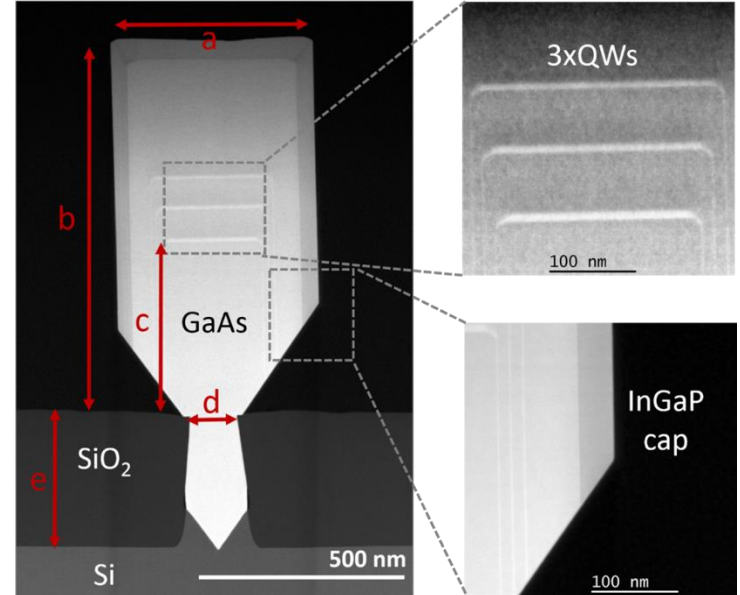
STI-process

Aspect-Ratio-Trapping (ART)

Basic processing scheme

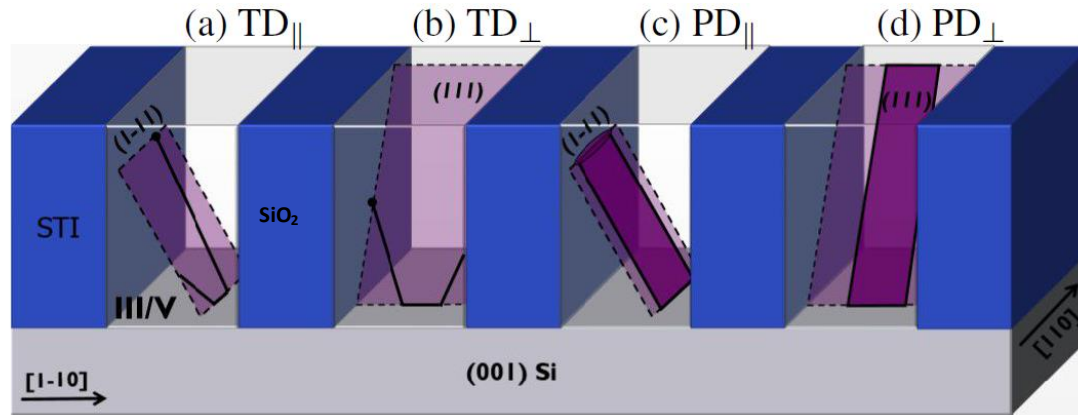


Reference sample

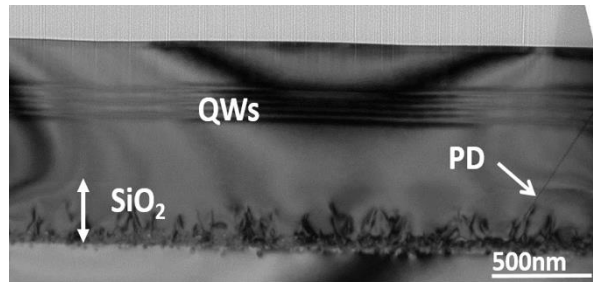


Aspect ratio trapping (ART)

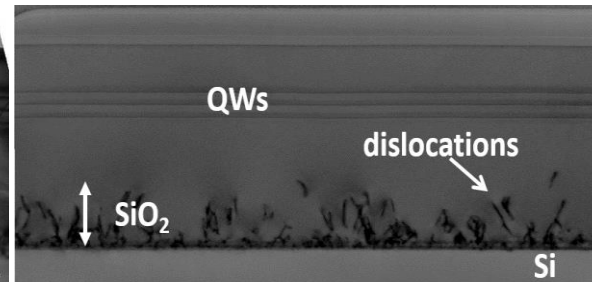
- High-AR SiO₂ trenches enable **trapping of threading dislocations**.



Longitudinal TEM-pictures



100nm trench



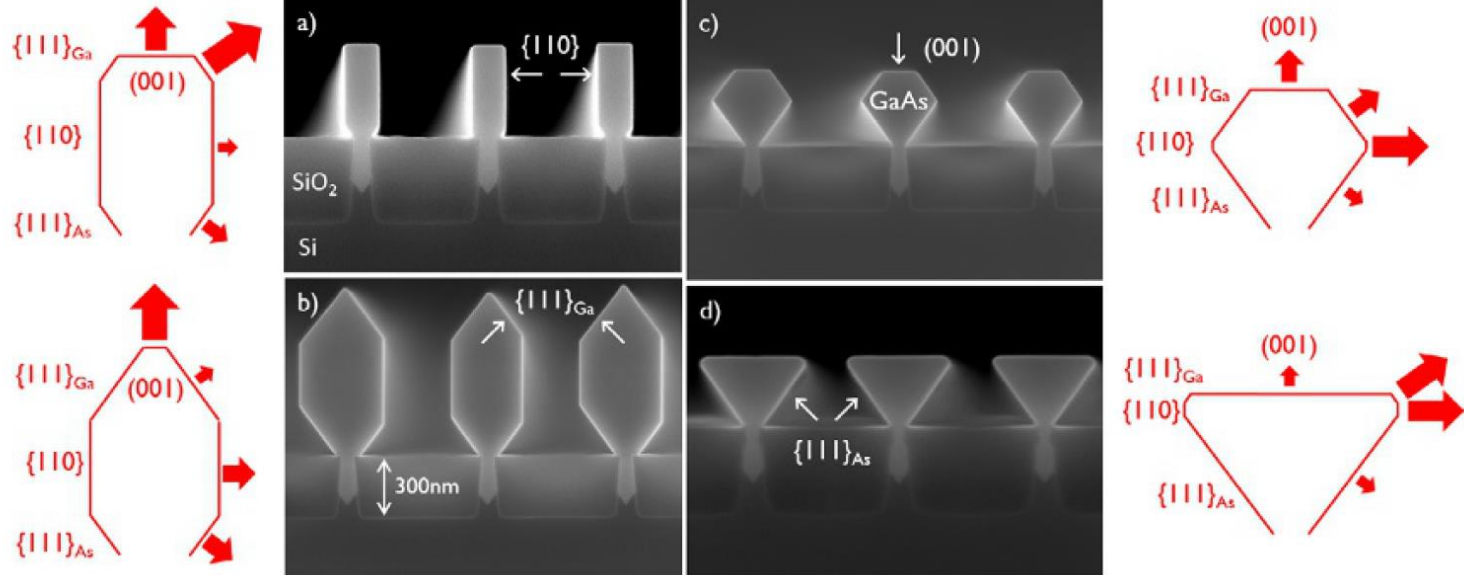
200nm trench

TD < 3×10⁶cm⁻²
(limited by measurement)
PD < 0.14–0.45μm-l

Nano-ridge engineering (NRE)

Control growth rate on different crystal planes to obtain well-defined nano-ridge profile

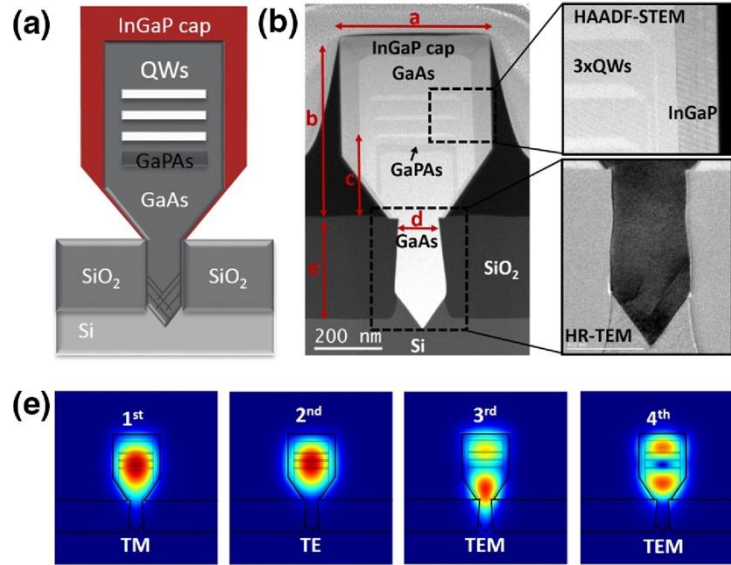
Higher growth rate facets disappear, whereas facets with **lower growth rates define the nano-ridge profile**



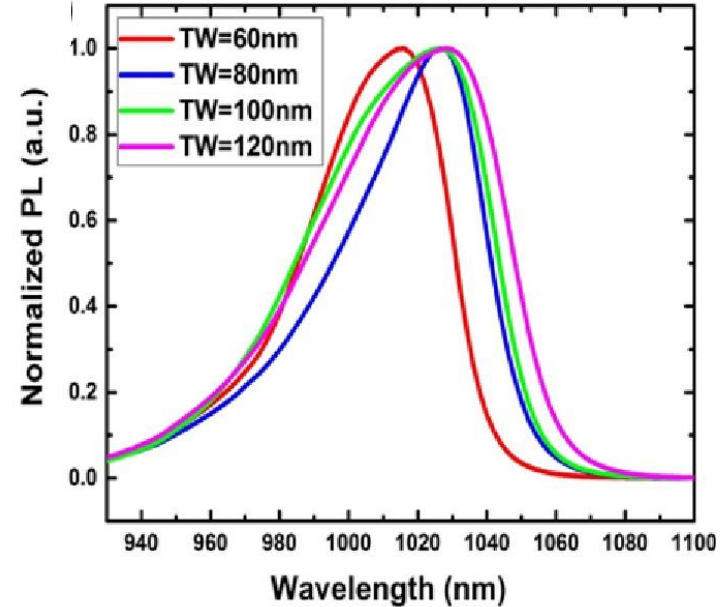
Optical Characterisation of InGaAs QWs

Photoluminescence Characteriation (PL)

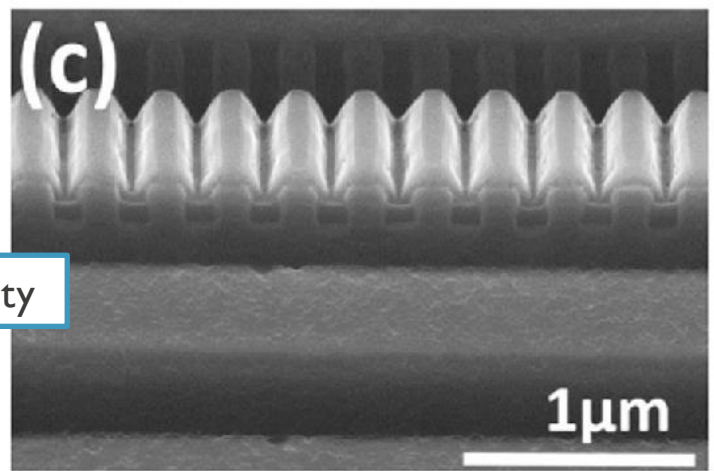
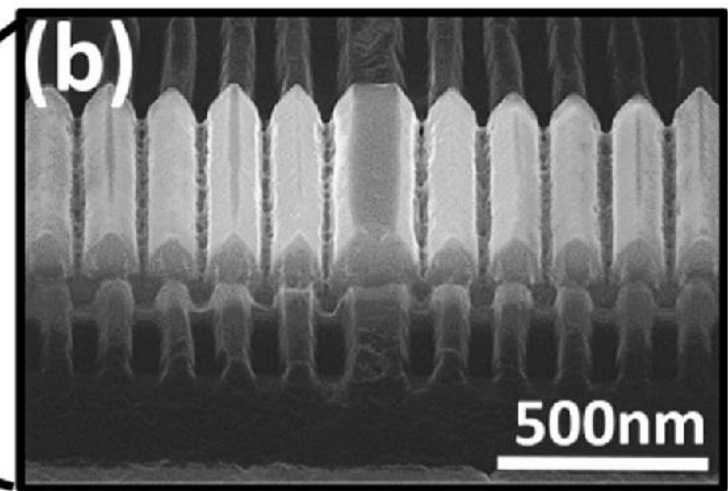
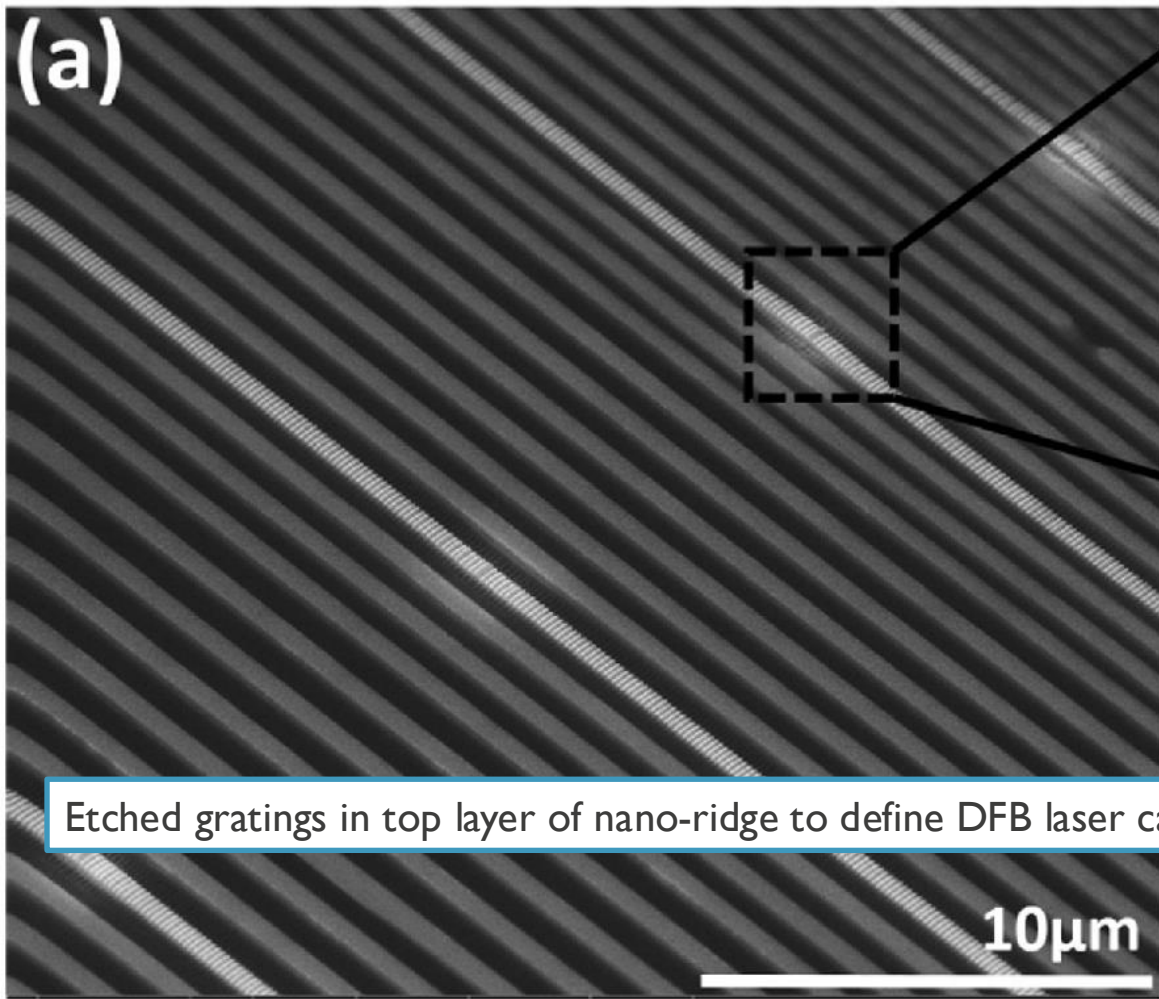
InGaP capping layer is essential



TE-mode (2nd) is strongly confined and has low substrate leakage

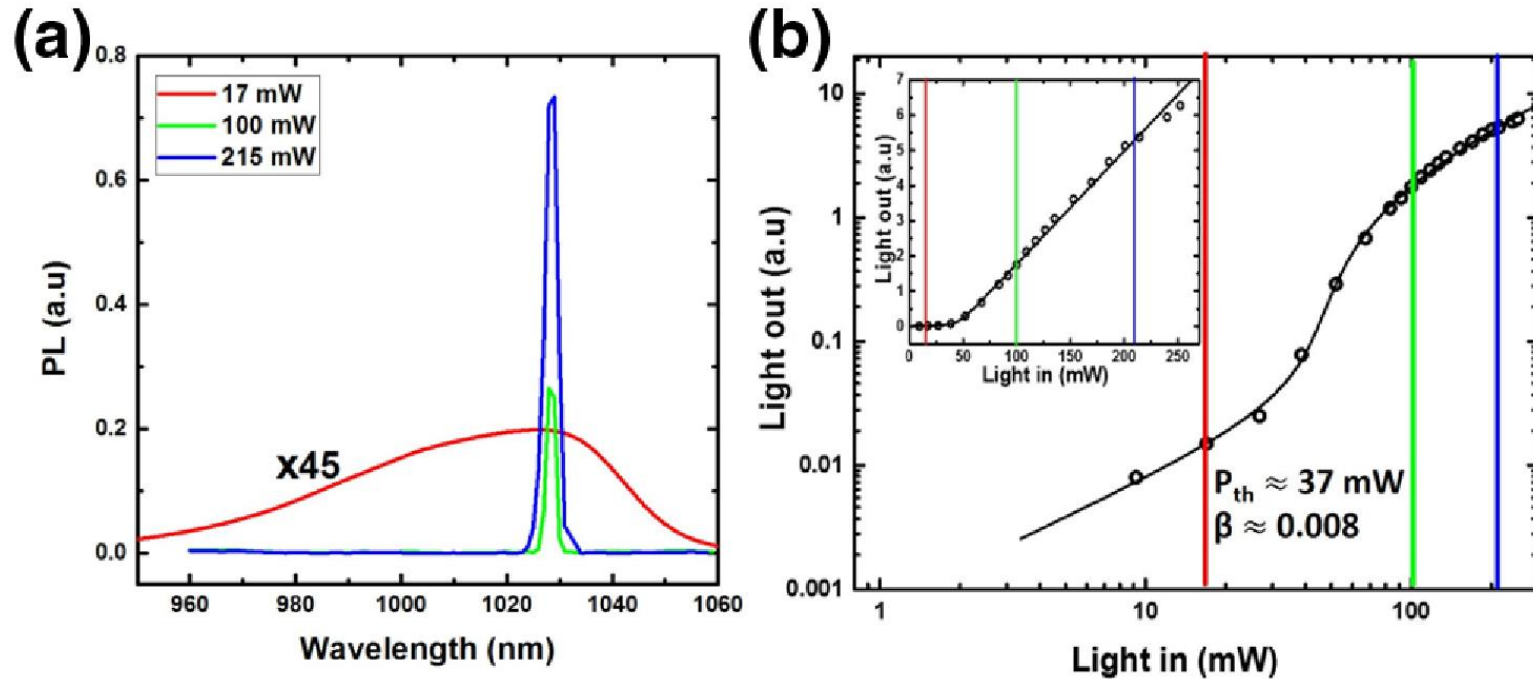


Yuting Shi e.a., "Optical pumped InGaAs/GaAs nano-ridge laser epitaxially grown on a standard 300-mm Si wafer," *Optica* 4, 1468-1473 (2017) <https://doi.org/10.1364/OPTICA.4.001468>



Optically Pumped Lasing (Etched Grating)

Successful single mode lasing was demonstrated

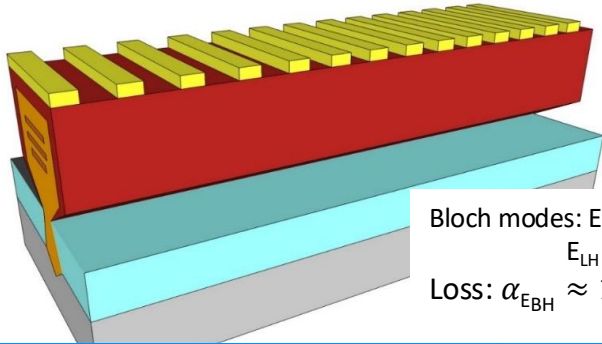


Yuting Shi e.a., "Optical pumped InGaAs/GaAs nano-ridge laser epitaxially grown on a standard 300-mm Si wafer," *Optica* 4, 1468-1473 (2017) <https://doi.org/10.1364/OPTICA.4.001468>

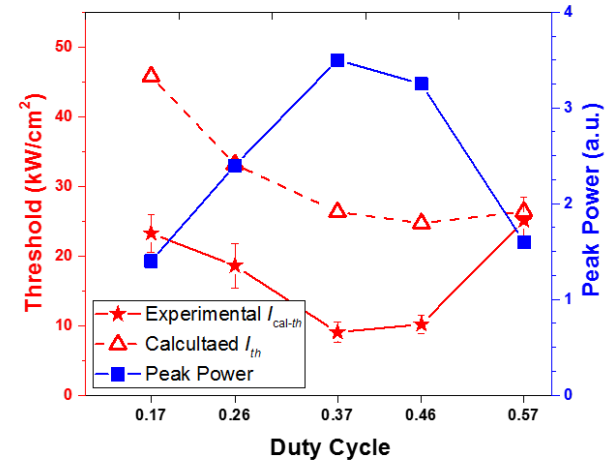
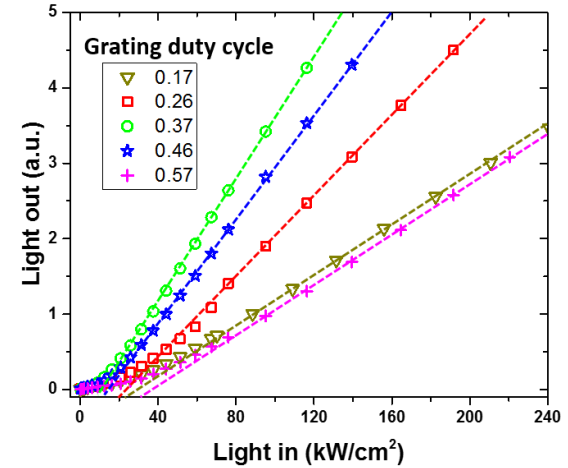
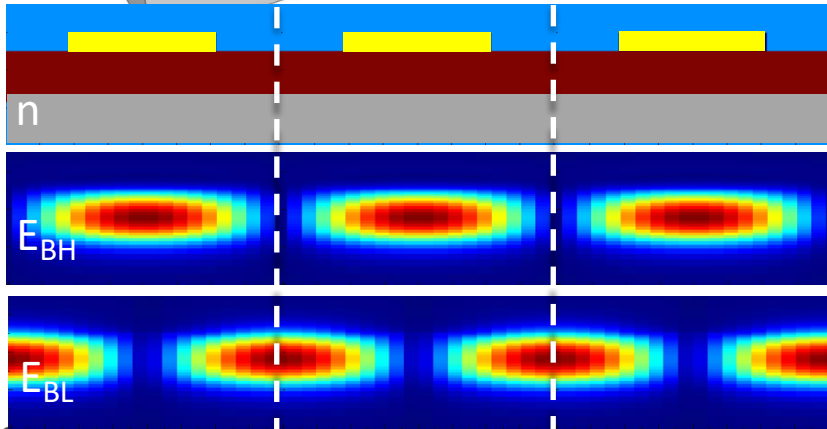
DFB-laser with Metal Grating

Continuous Au-contact: $\alpha_{TE} = 74 \text{ cm}^{-1}$

Grating with 40% duty cycle: $\alpha_{EBL} = 7 \text{ cm}^{-1}$



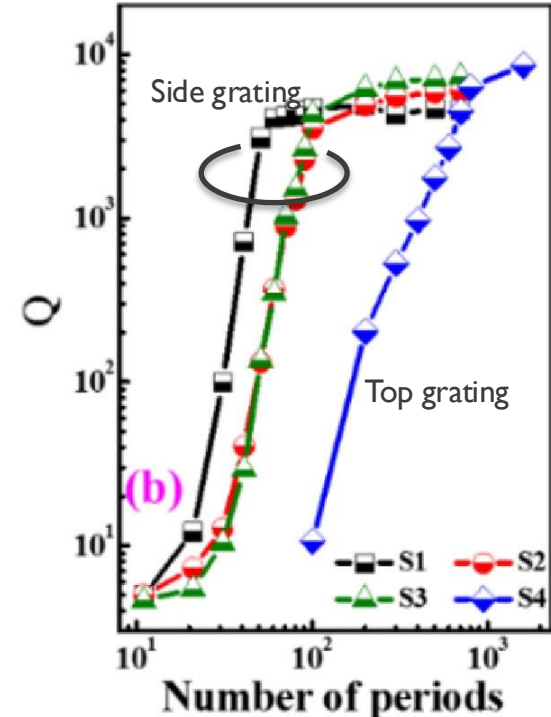
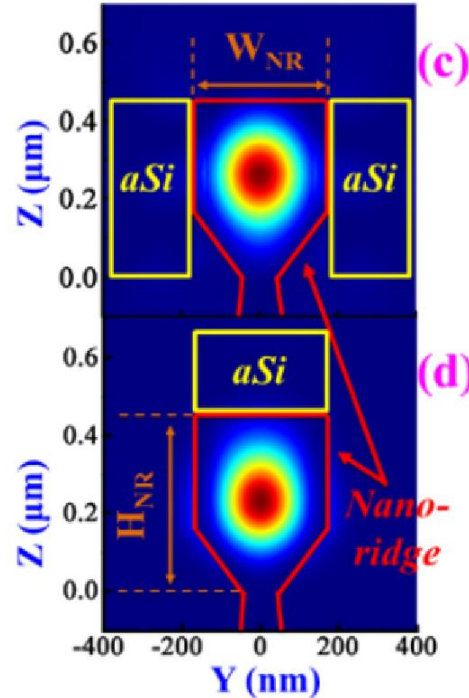
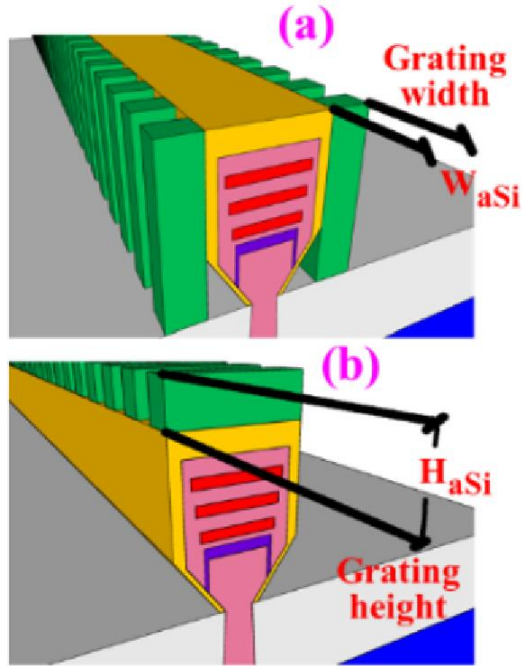
Bloch modes: E_{BH} (high overlap)
 E_{LH} (low overlap)
 Loss: $\alpha_{EBH} \approx 10 \times \alpha_{EBL}$



Amorphous Silicon Grating

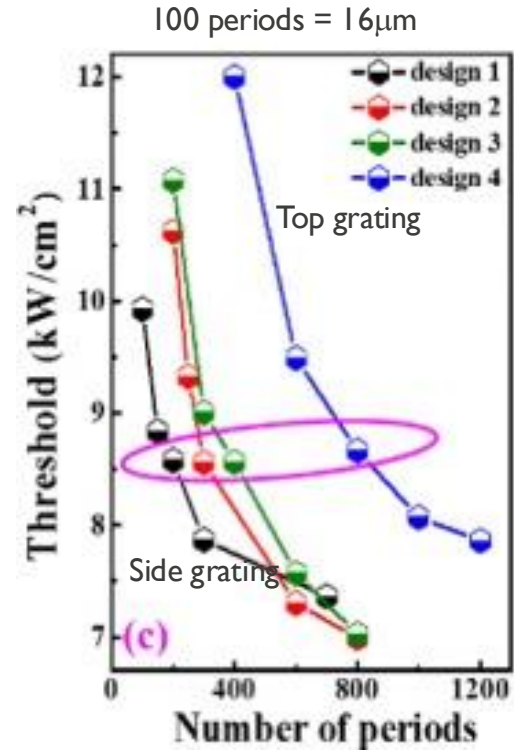
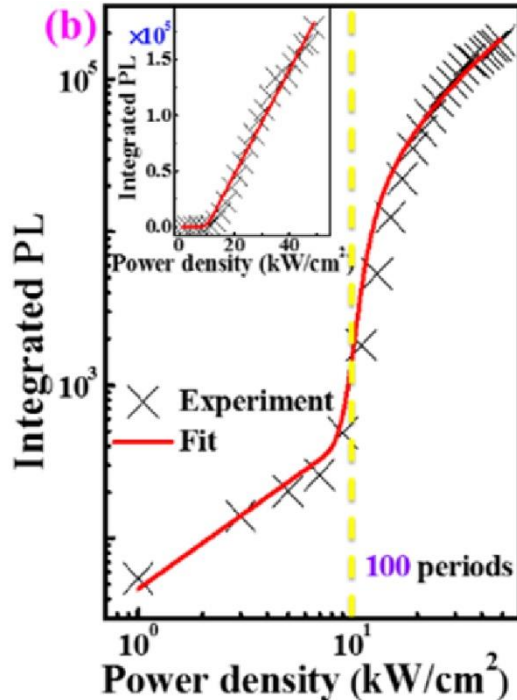
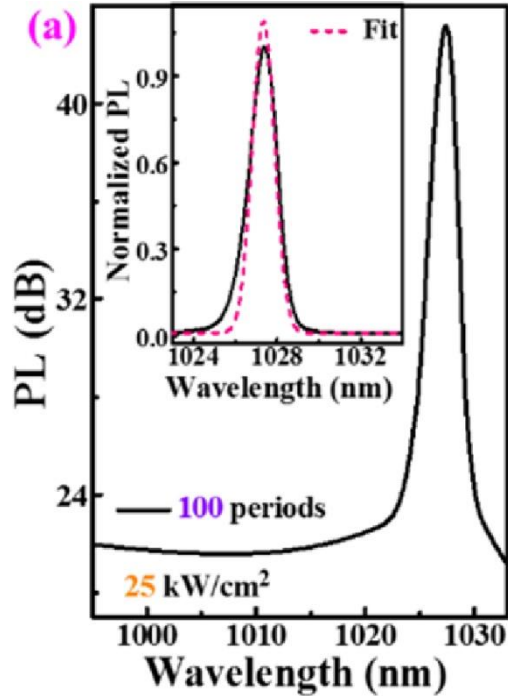
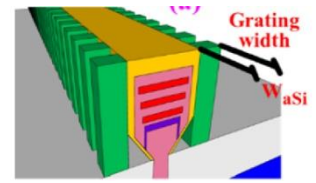
Grating deposited on sides of nano-ridge allows for strong feedback

■ InGaP ■ GaAs ■ InGaAs ■ aSi ■ GaPAs ■ SiO_x ■ Si substrate



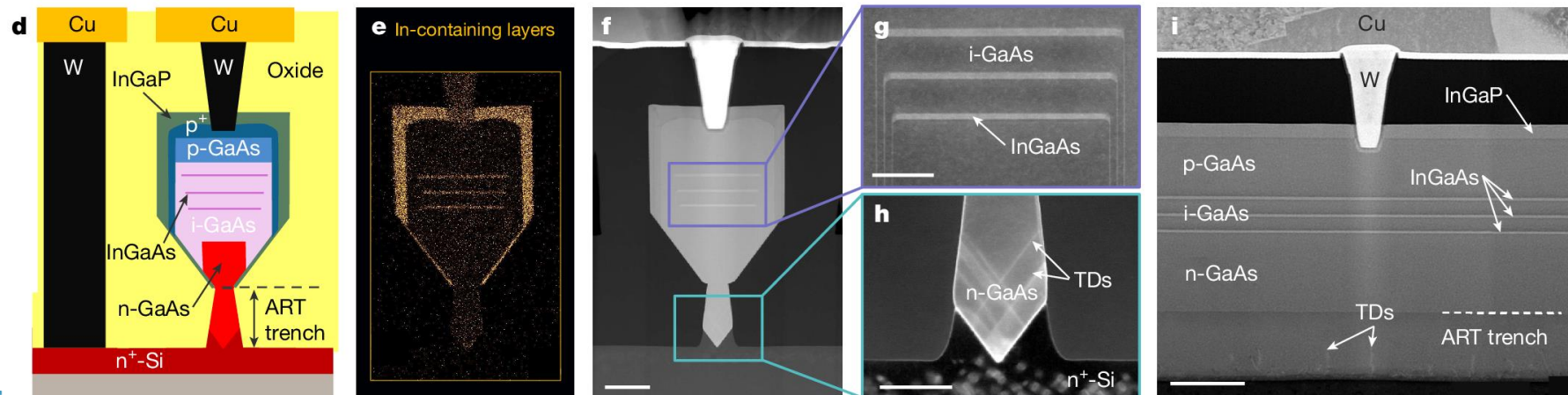
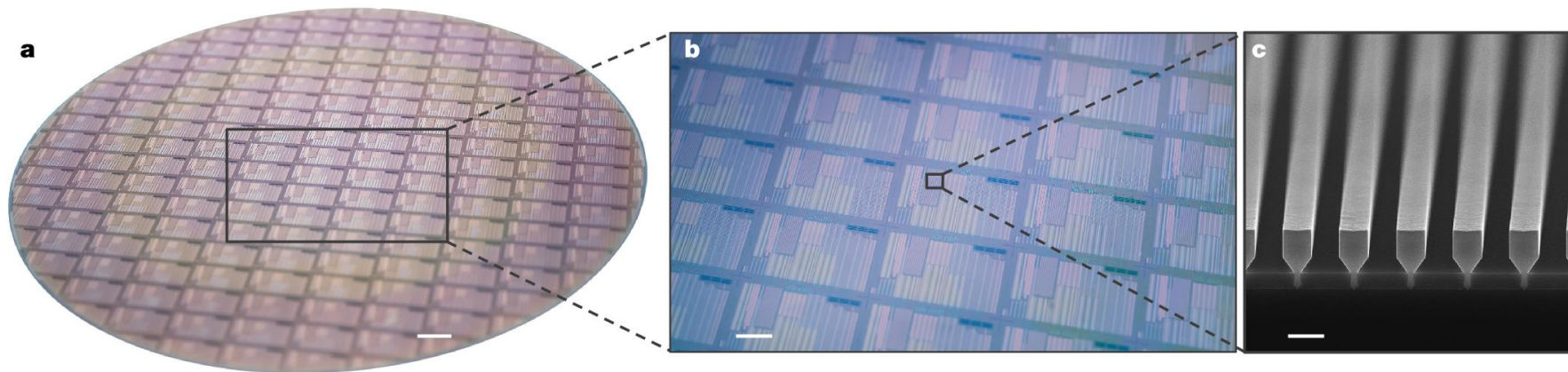
Lasing from 16 μm laser !

Grating deposited on sides of nano-ridge allow for strong feedback



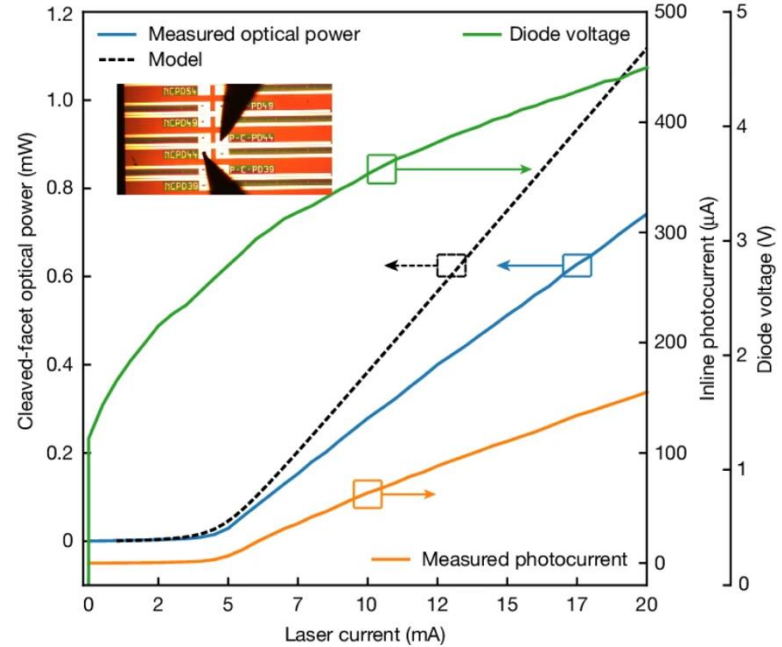
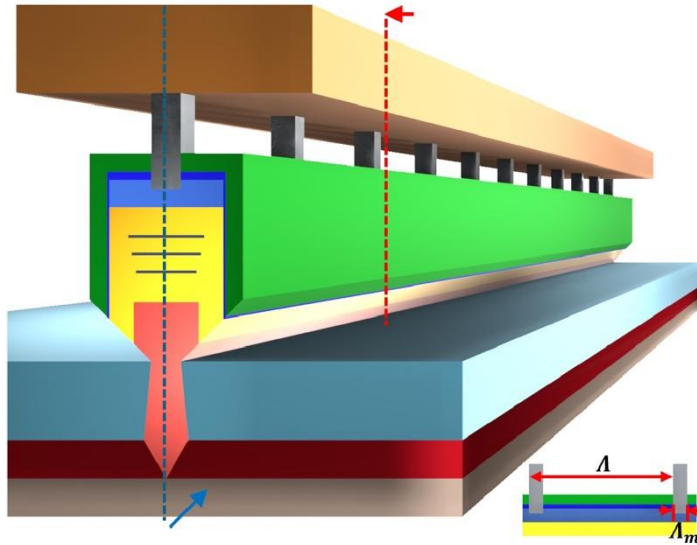
Electrically Injected Devices

Challenge: Electrical Contact Strongly Affects Optical Mode



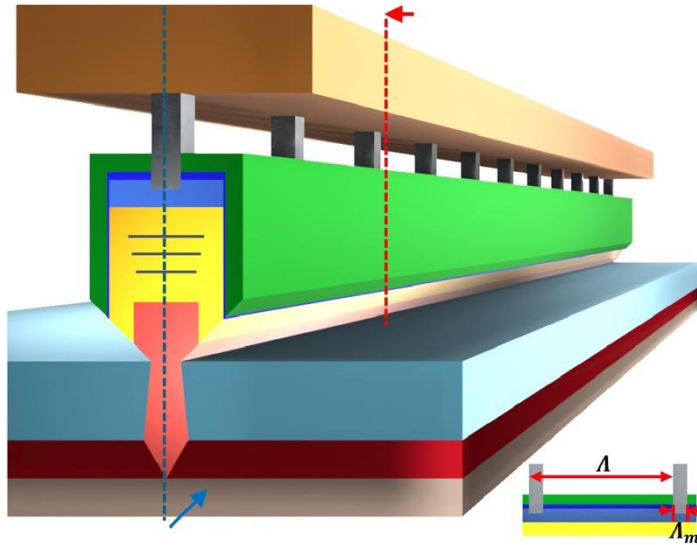
Metal Contacts Expected to Result in High Loss

Nevertheless: low threshold lasing observed !

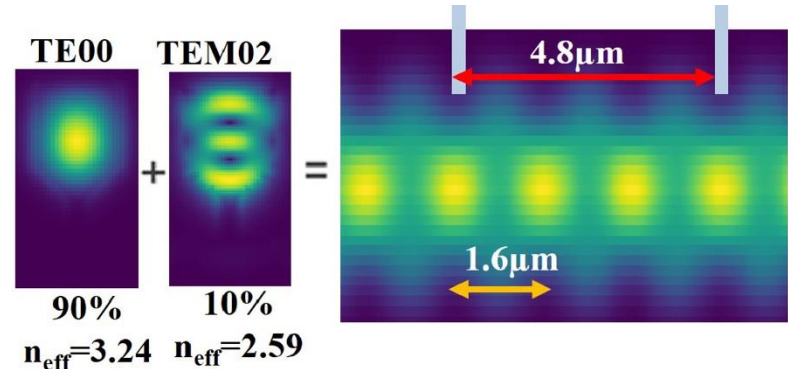
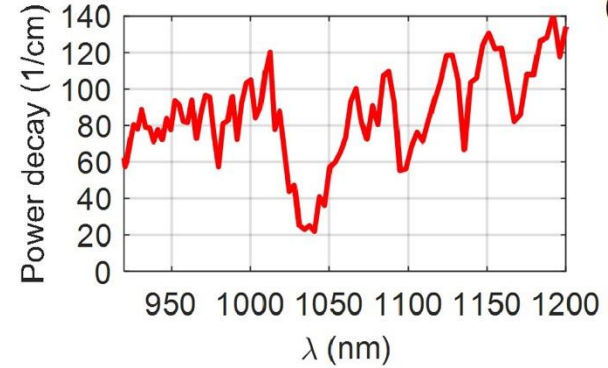


Metal Contacts Expected to Result in High Loss

But: Mode beating suppresses loss in metal contacts

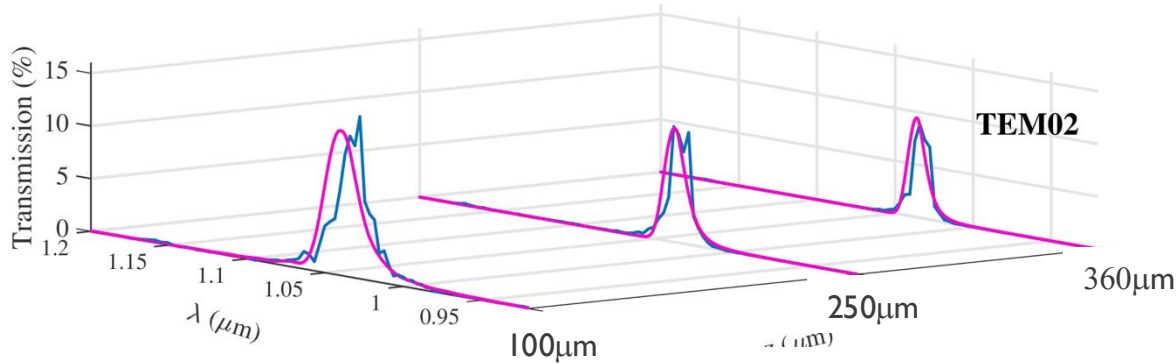
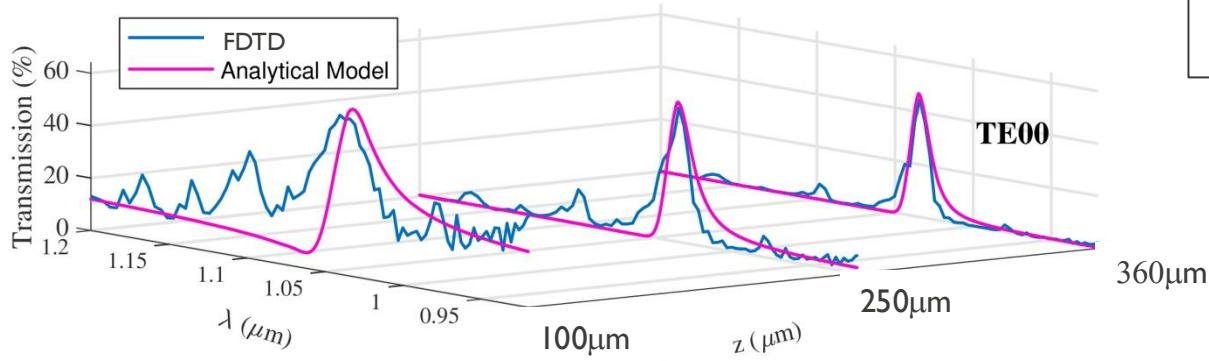


Simulation of transmitted power (FDTD)



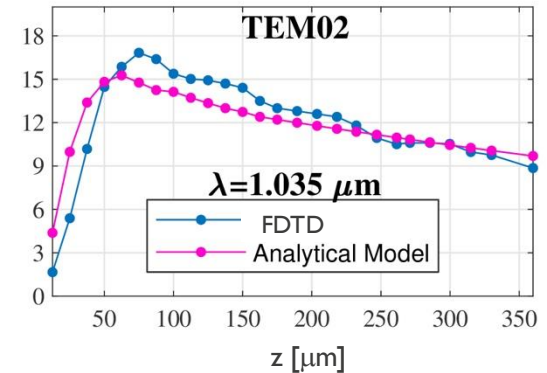
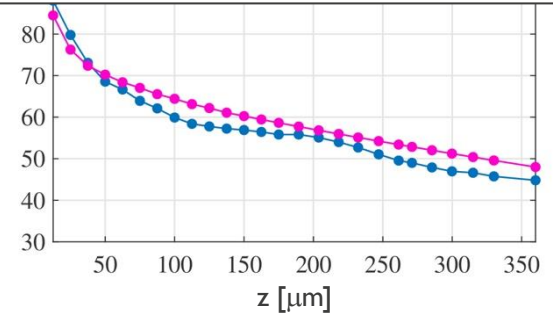
Analytical Model Confirms FDTD Simulations

Waveguide excited by mode I, at $z=0\mu\text{m}$



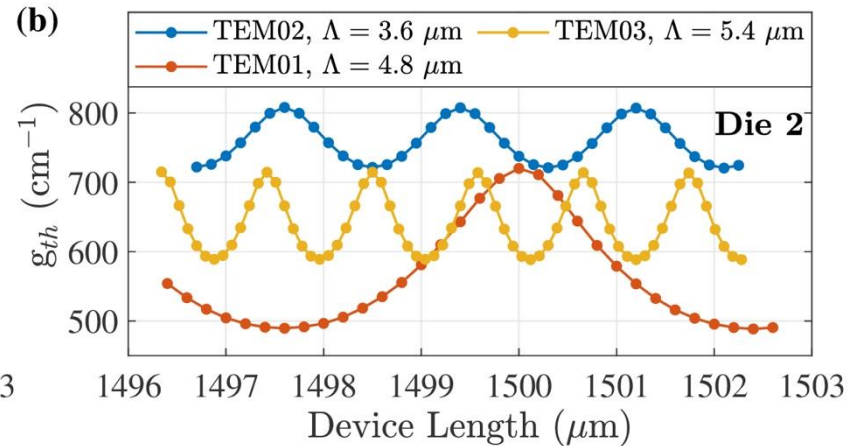
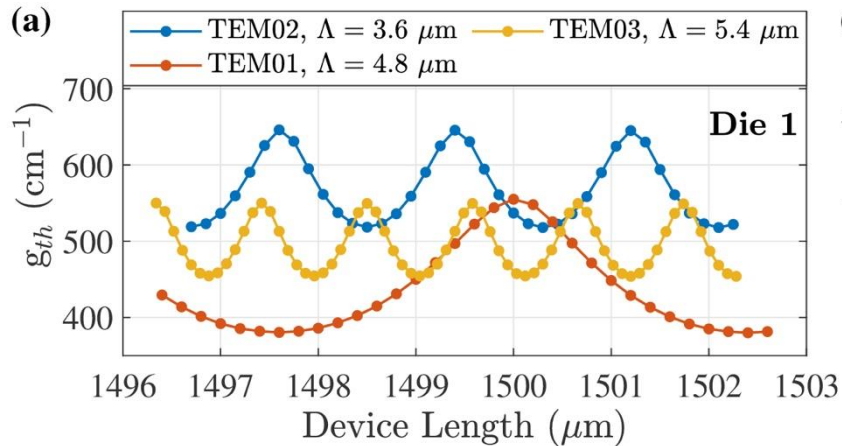
$$\frac{dE_1(z)}{dz} = -j \frac{\kappa_0^2}{2\beta_1} E_1 \frac{\int \Delta \epsilon U_1^2 dA}{\int U_1^2 dA} - j \frac{\kappa_0^2}{2\beta_1} e^{-j(\beta_2 - \beta_1)z} E_2 \frac{\int \Delta \epsilon U_1 U_2 dA}{\int U_1^2 dA}$$

$$\frac{dE_2(z)}{dz} = -j \frac{\kappa_0^2}{2\beta_2} E_2 \frac{\int \Delta \epsilon U_2^2 dA}{\int U_2^2 dA} - j \frac{\kappa_0^2}{2\beta_2} e^{-j(\beta_1 - \beta_2)z} E_1 \frac{\int \Delta \epsilon U_1 U_2 dA}{\int U_2^2 dA}$$



Analytical model: threshold gain prediction

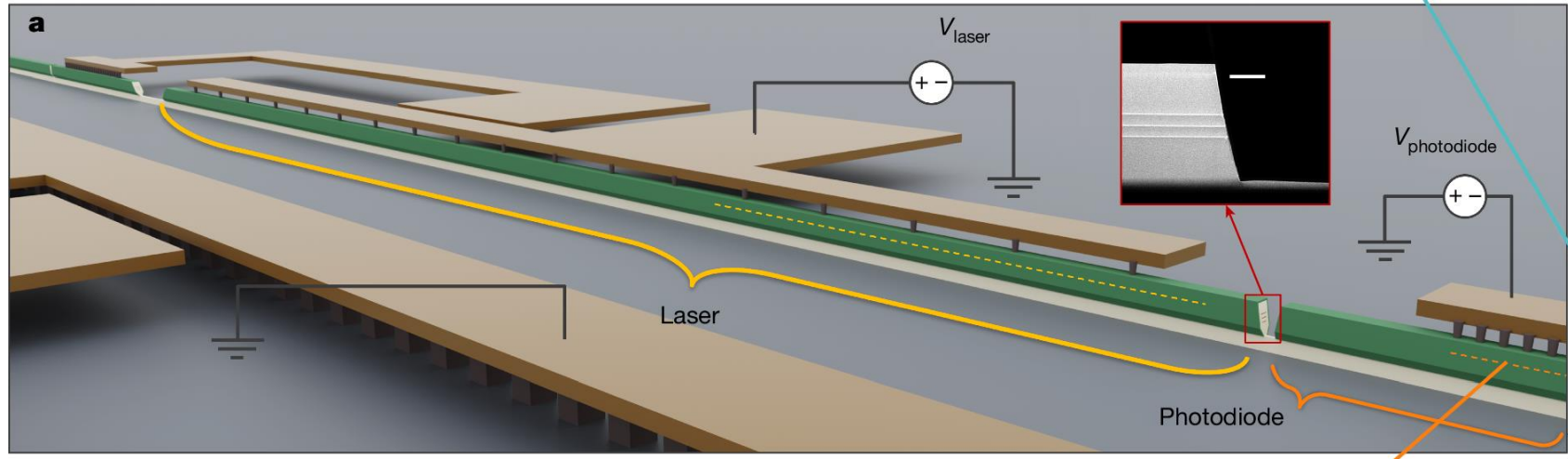
Different modes result in different beating length and different lasing wavelength



Exact cavity length impacts laser threshold

Laser Layout

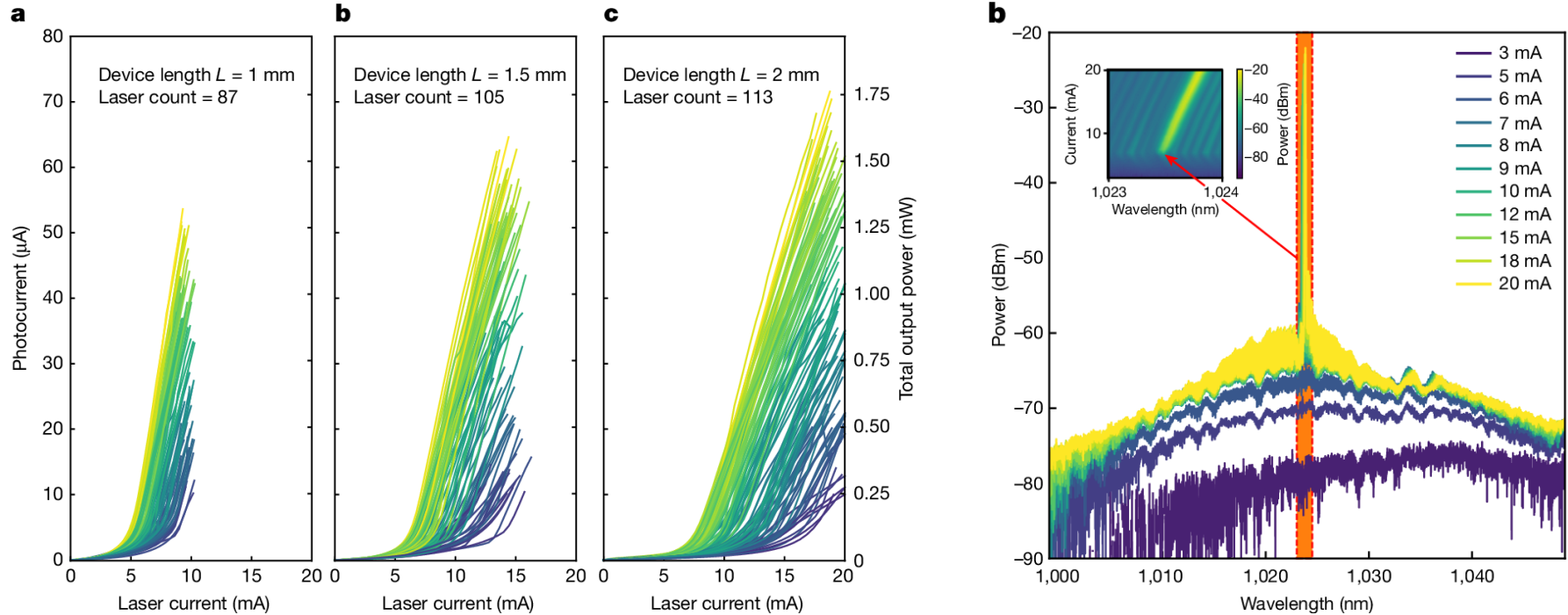
Integrated photodiode allows waferlevel characterisation



De Koninck, Y., et al. GaAs nano-ridge laser diodes fully fabricated in a 300-mm CMOS pilot line. *Nature* **637**, 63–69 (2025). <https://doi.org/10.1038/s41586-024-08364-2>

Waferscale Characterisation of Nano-Ridge Laser

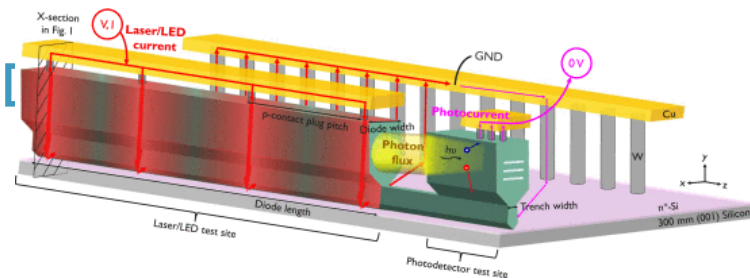
Low threshold and single mode lasing



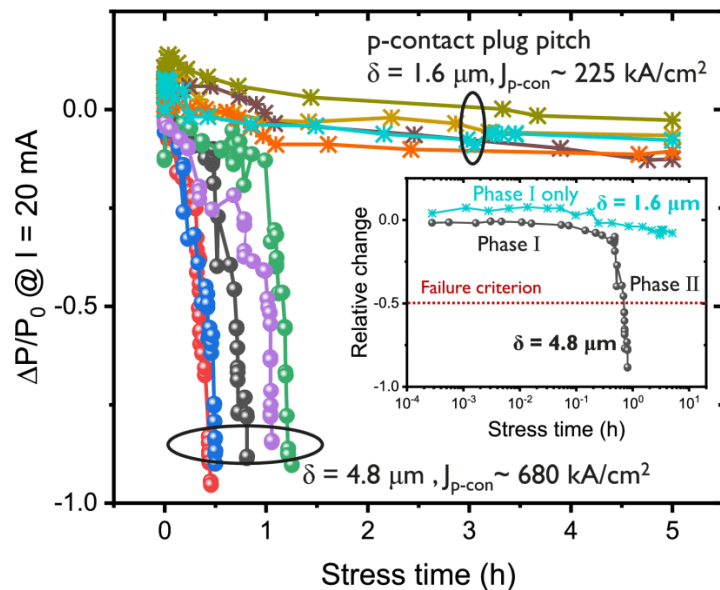
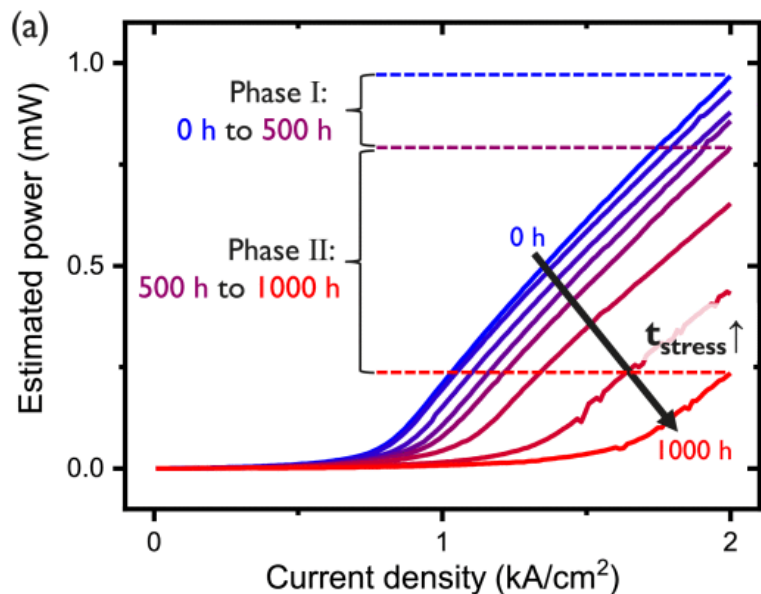
De Koninck, Y., et al. GaAs nano-ridge laser diodes fully fabricated in a 300-mm CMOS pilot line. *Nature* **637**, 63–69 (2025). <https://doi.org/10.1038/s41586-024-08364-2>

Degradation Mechanisms in Nano-Ridge Lasers

Sparse Contact Plugs Result in Limited Lifetime

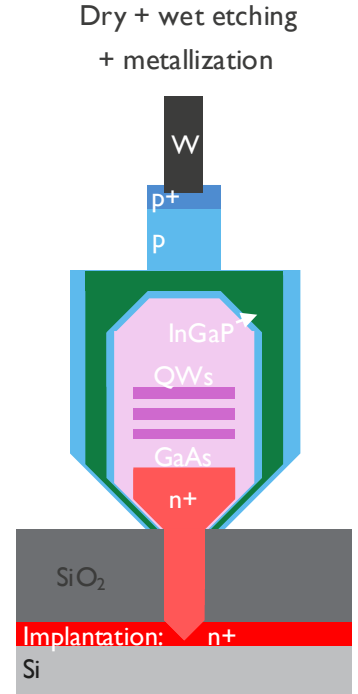
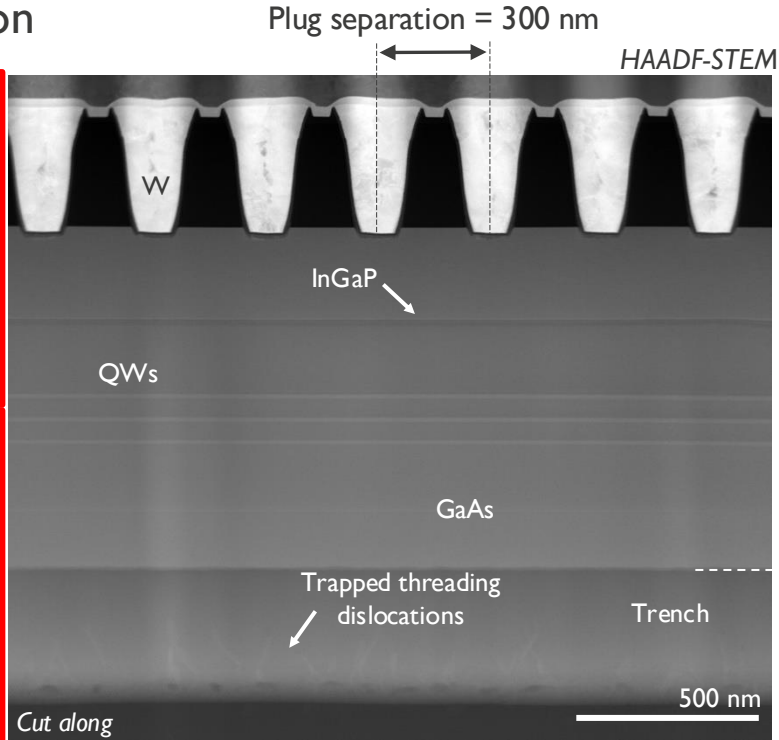
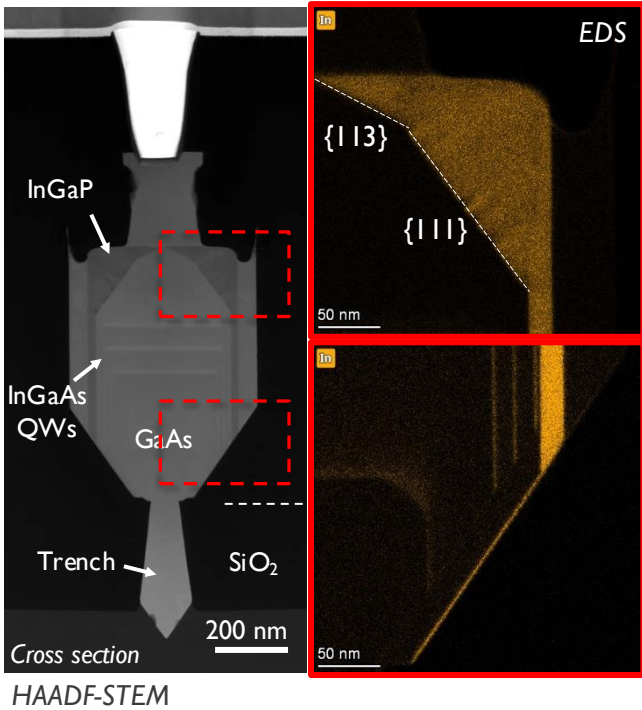


Lasers devices with 4.8 μm plug pitch



NR2.0: Etched fin separates optical mode from contact plugs

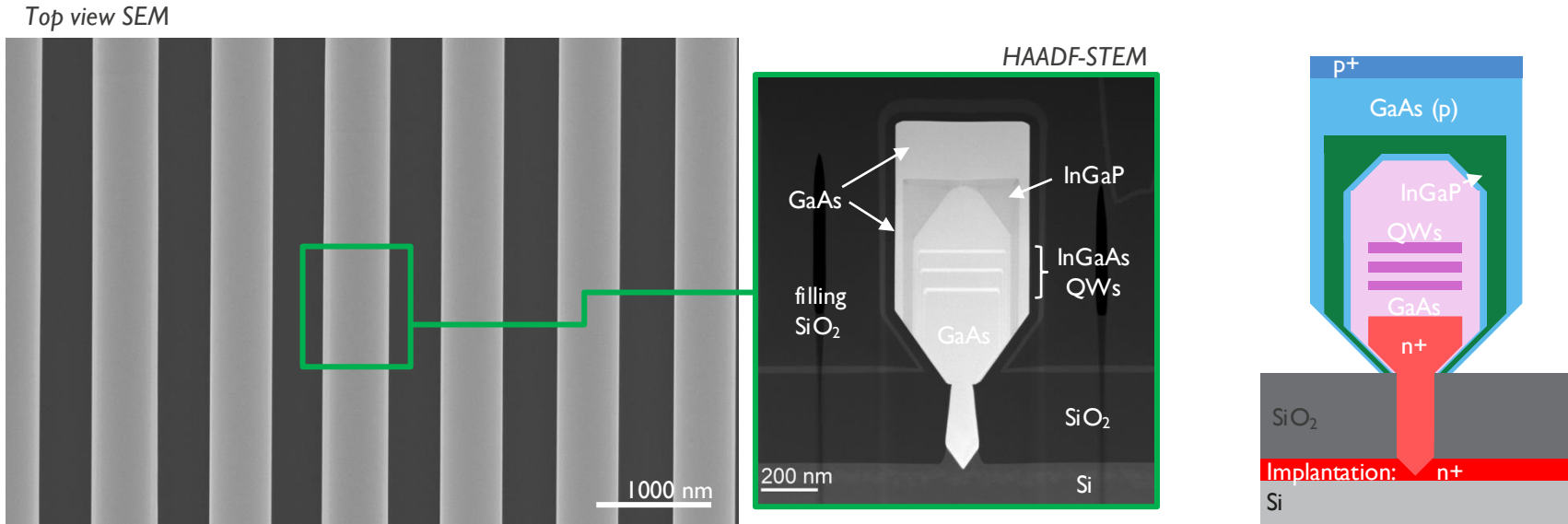
Etching of the fin and metallization



- InGaP (001) < 10 nm
- Full InGaP passivation of the active region

NR2.0: device processing

Epitaxial growth



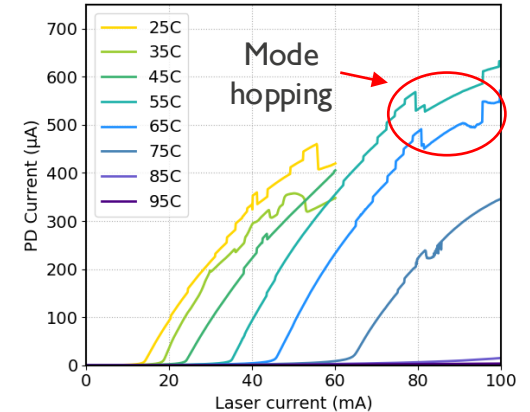
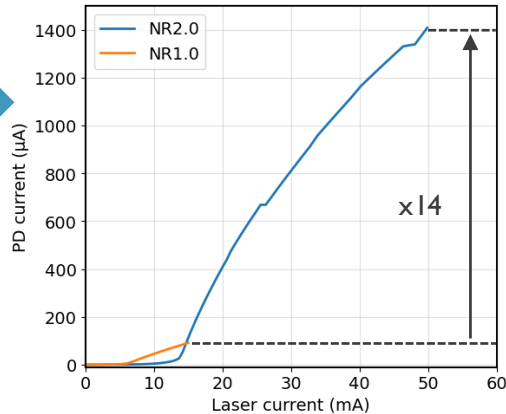
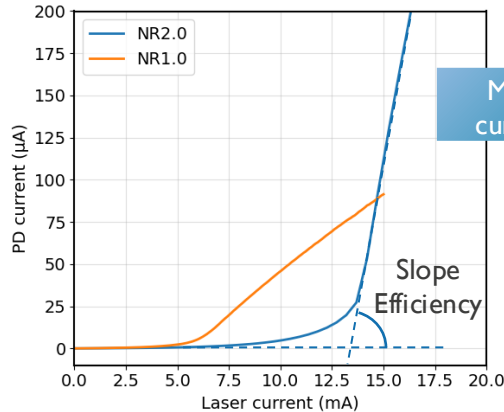
Uniform nano-ridges with all layers successfully developed

Wafer-scale laser characterization – Preliminary results

Read-out of the inline nano-ridge photodiodes

Key results

- Higher threshold current than NR1.0 (13 mA vs 5 mA)
- 4x max slope efficiency
- Up to 14x in output power (assuming comparable photodiode responsivity)
- Lasing operation at higher temperature than NR1.0 (75 °C vs 55 °C)

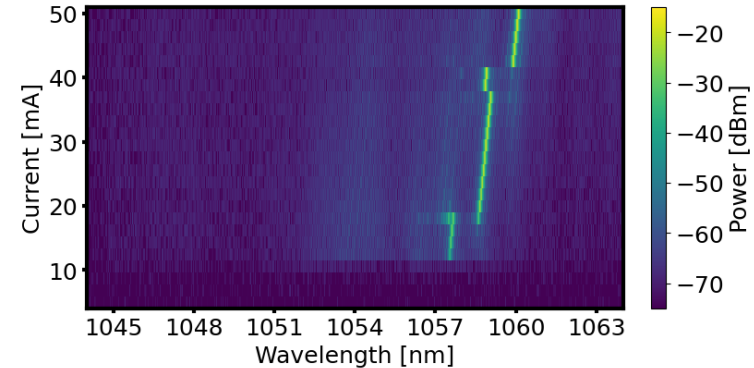
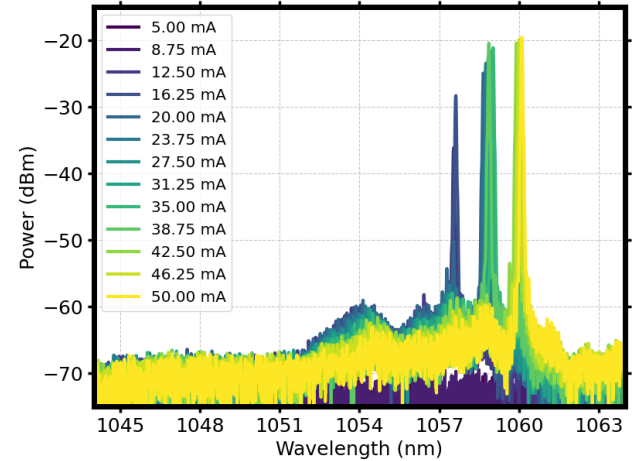


Laser spectrum analysis – Preliminary results

Detection at a cleaved laser facet

Key results

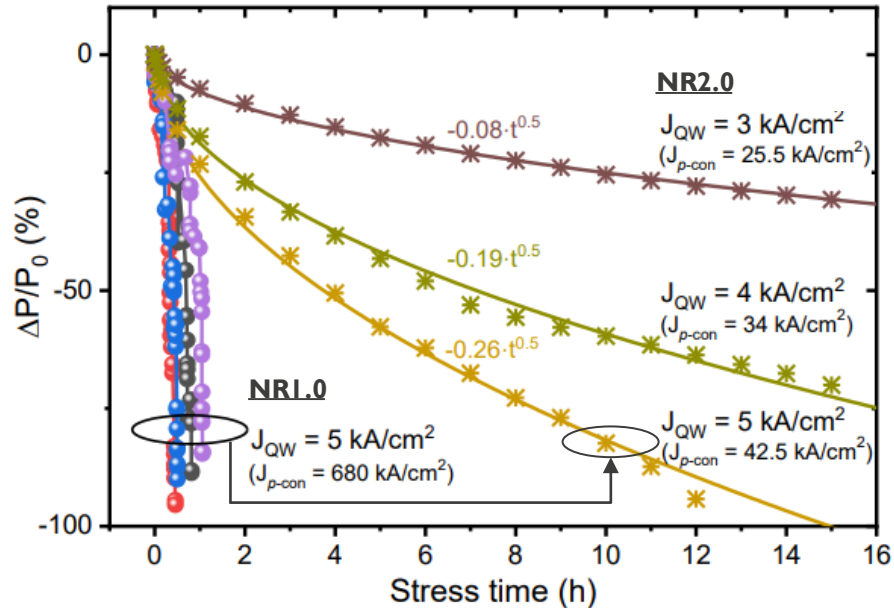
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- 4x max slope efficiency
- Up to 14x in output power (assuming comparable photodiode responsivity)
- Lasing operation at higher temperature than NRI.0 (75 °C vs 55 °C)
- Multimode emission centred around 1050 nm



Wafer-scale reliability tests – Preliminary results

P-contact-breakdown failure mode solved

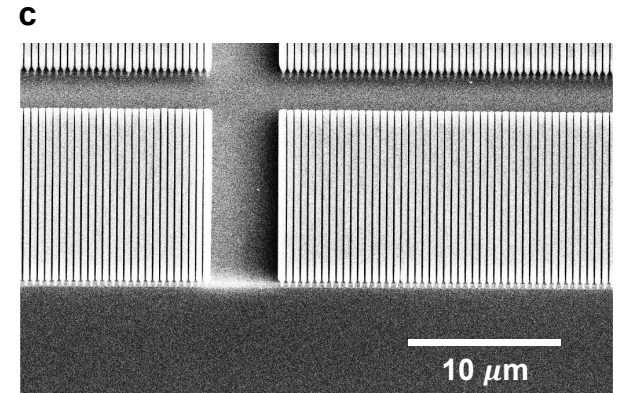
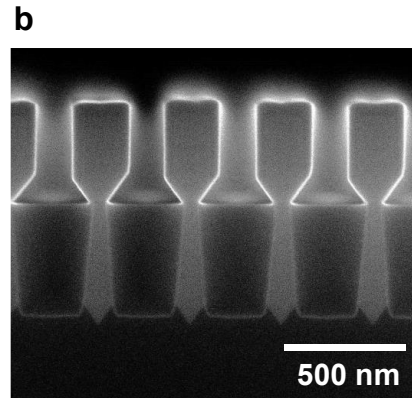
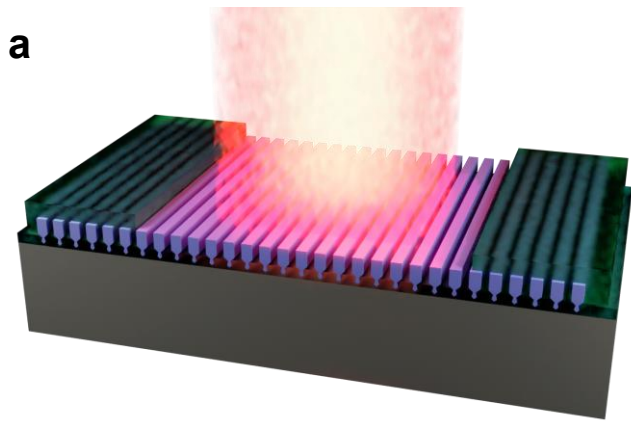
- x10 lifetime improvement at $J_{QW} = 5 \text{ kA/cm}^2$
- Gradual degradation in the output power likely linked to an impurity diffusion process



New Directions

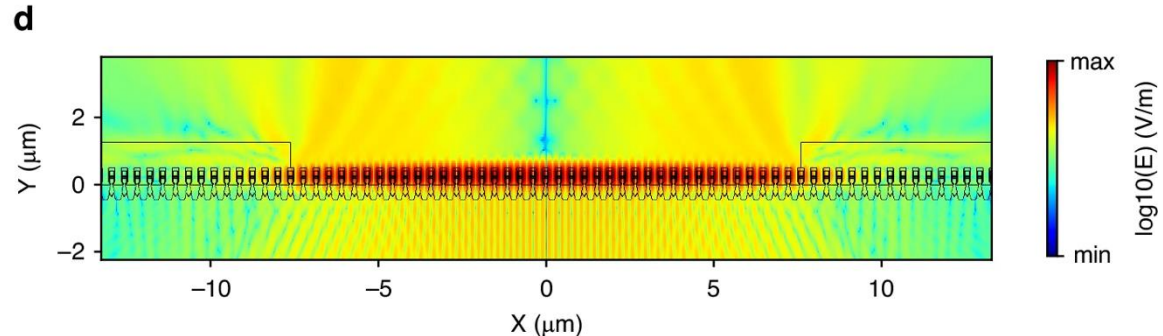
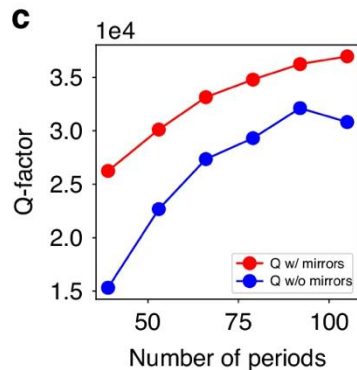
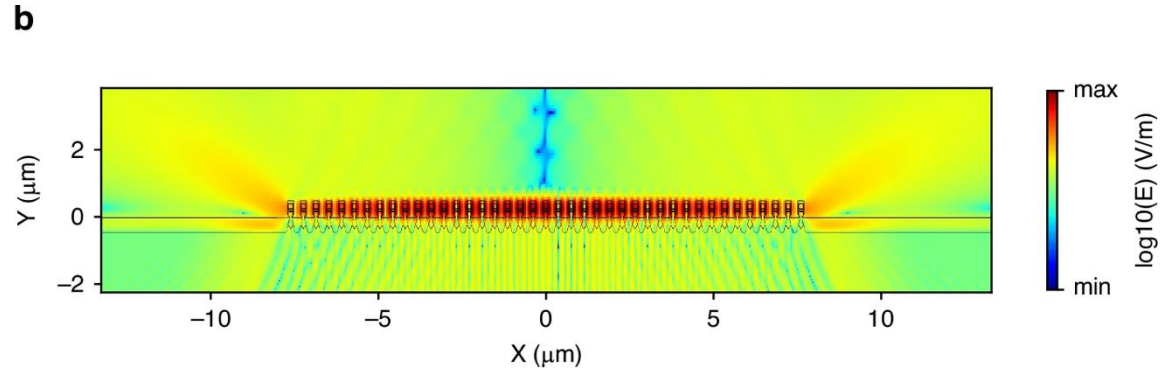
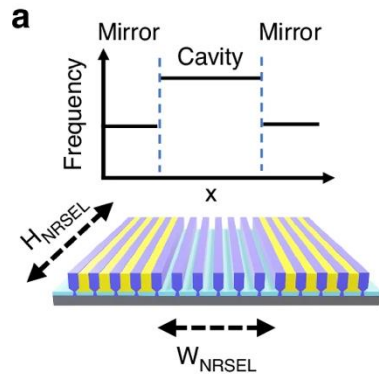
Nano-Ridge Surface Emitting Lasers

Can we exploit 1D periodic arrays of nano-ridges to realize more complex devices ?



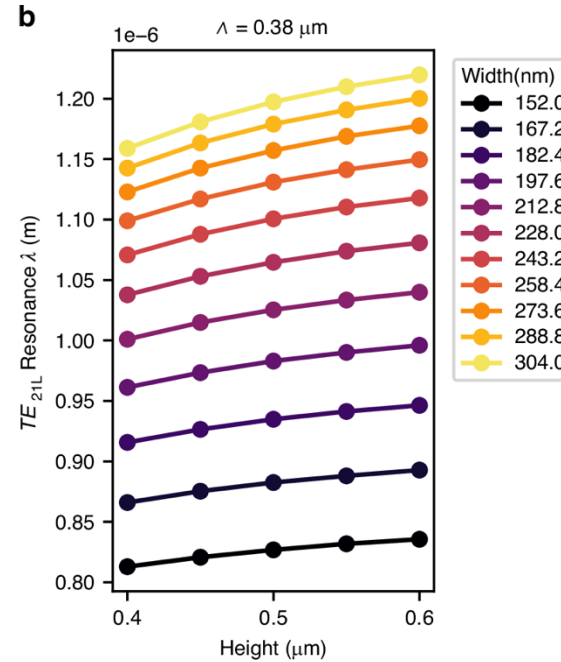
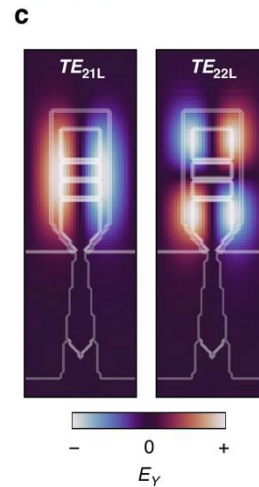
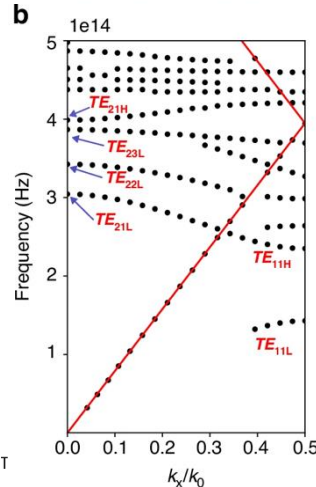
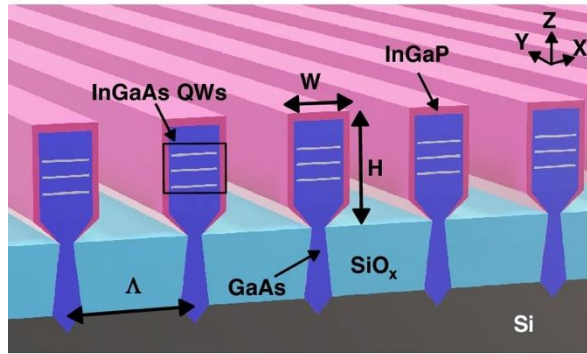
Nano-Ridge Surface Emitting Lasers

Can we exploit 1D periodic arrays of nano-ridges to realize more complex devices ?



Nano-Ridge Surface Emitting Lasers

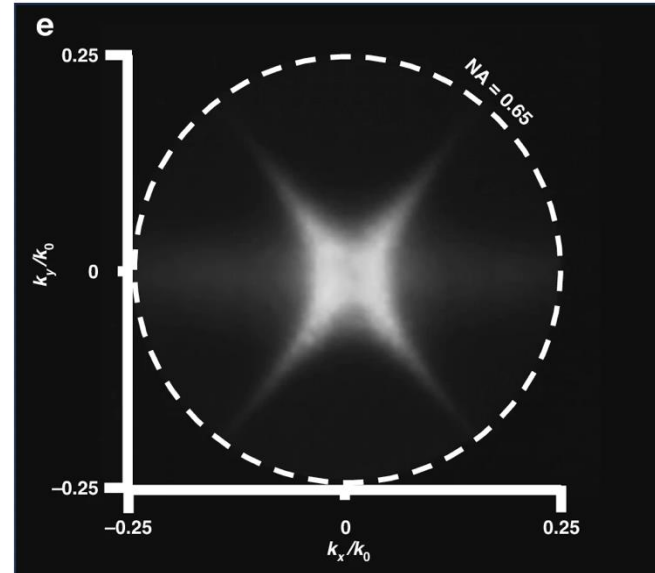
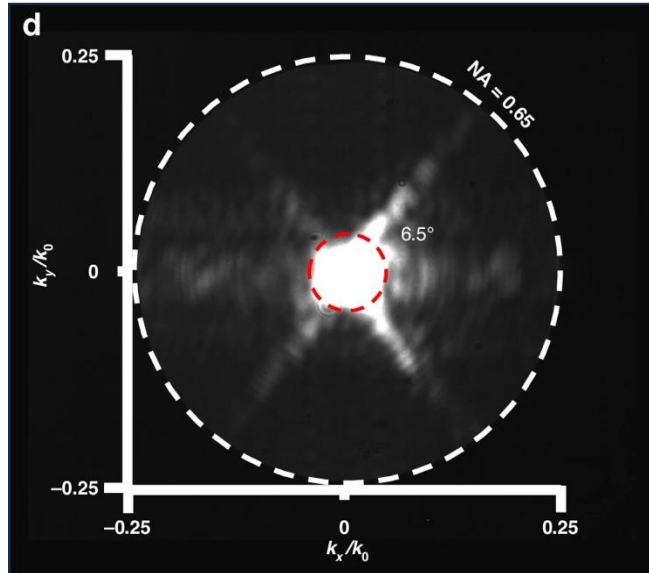
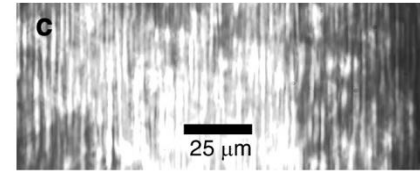
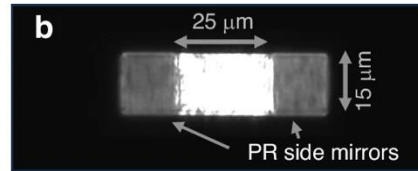
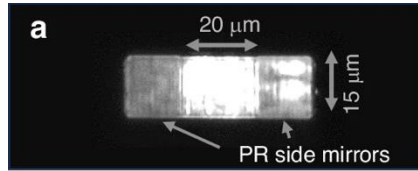
Matching the device parameters to gain bandwidth ($\sim 1050\text{nm}$)



Challenge: mask fixed upfront - no room to vary period

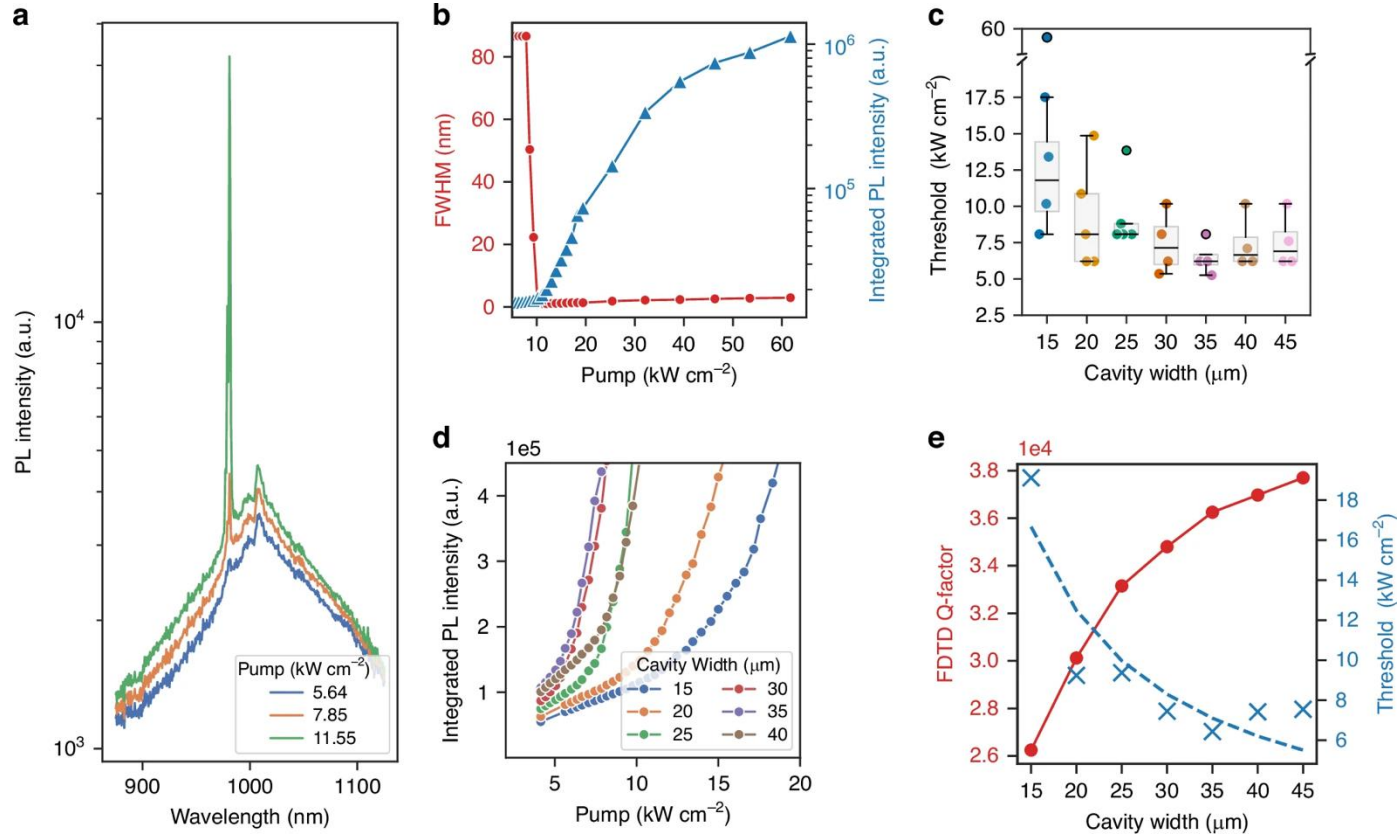
Nano-Ridge Surface Emitting Lasers

Far- and near-field images



Nano-Ridge Surface Emitting Lasers

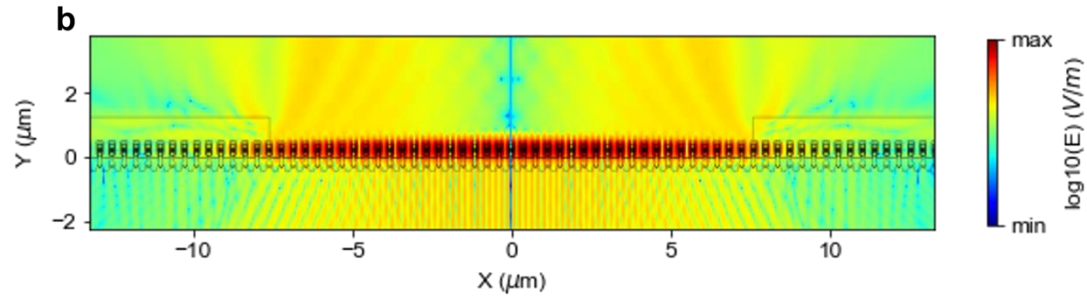
Clear single mode lasing observed under optical pumping (7 ns pulses)



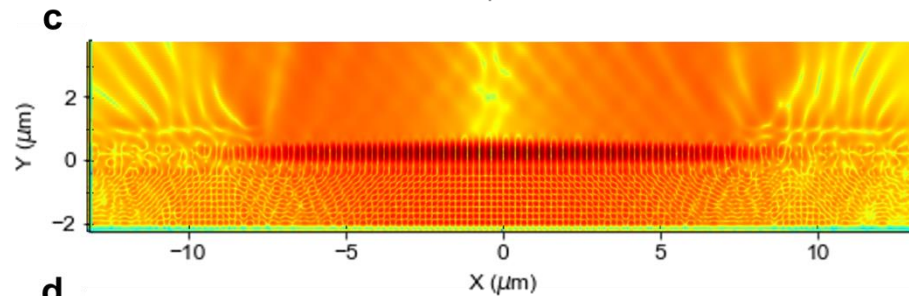
Nano-Ridge Surface Emitting Lasers

Room for further improvement: Effect of bottom mirror

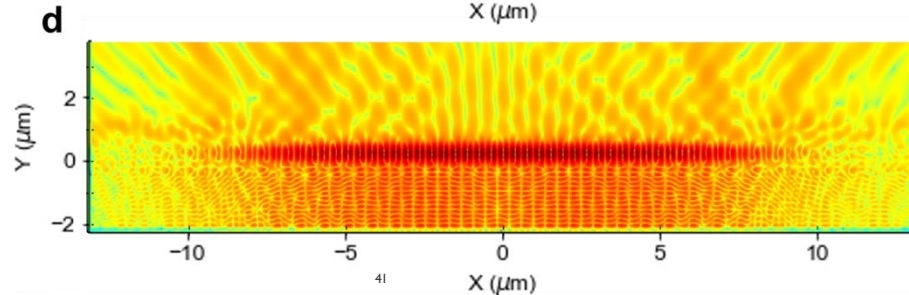
No mirror
 $Q=20k$



Mirror in phase
 $Q=28k$



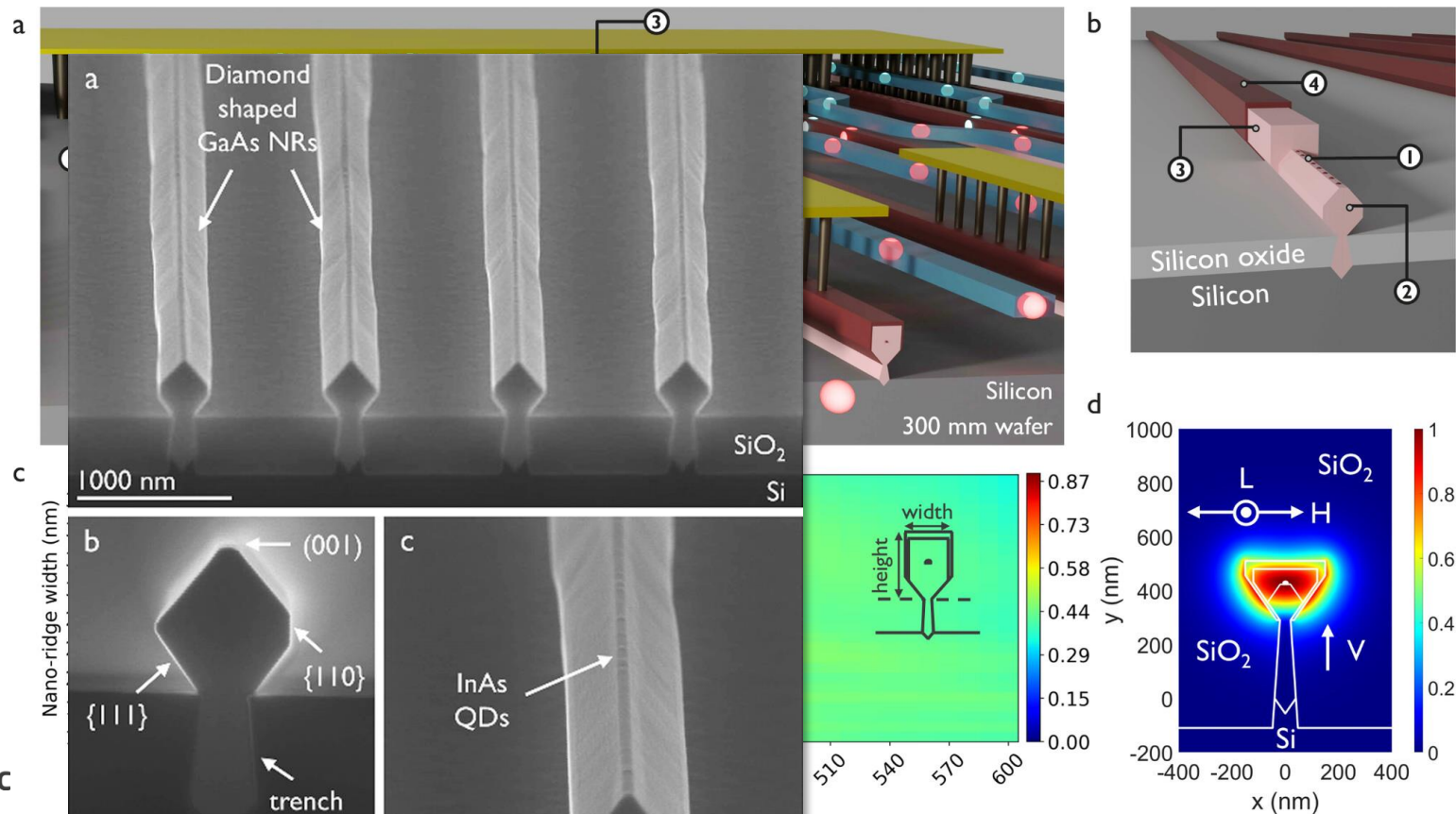
Mirror out of phase
 $Q=319k$



InAs QDs on 300mm Wafers

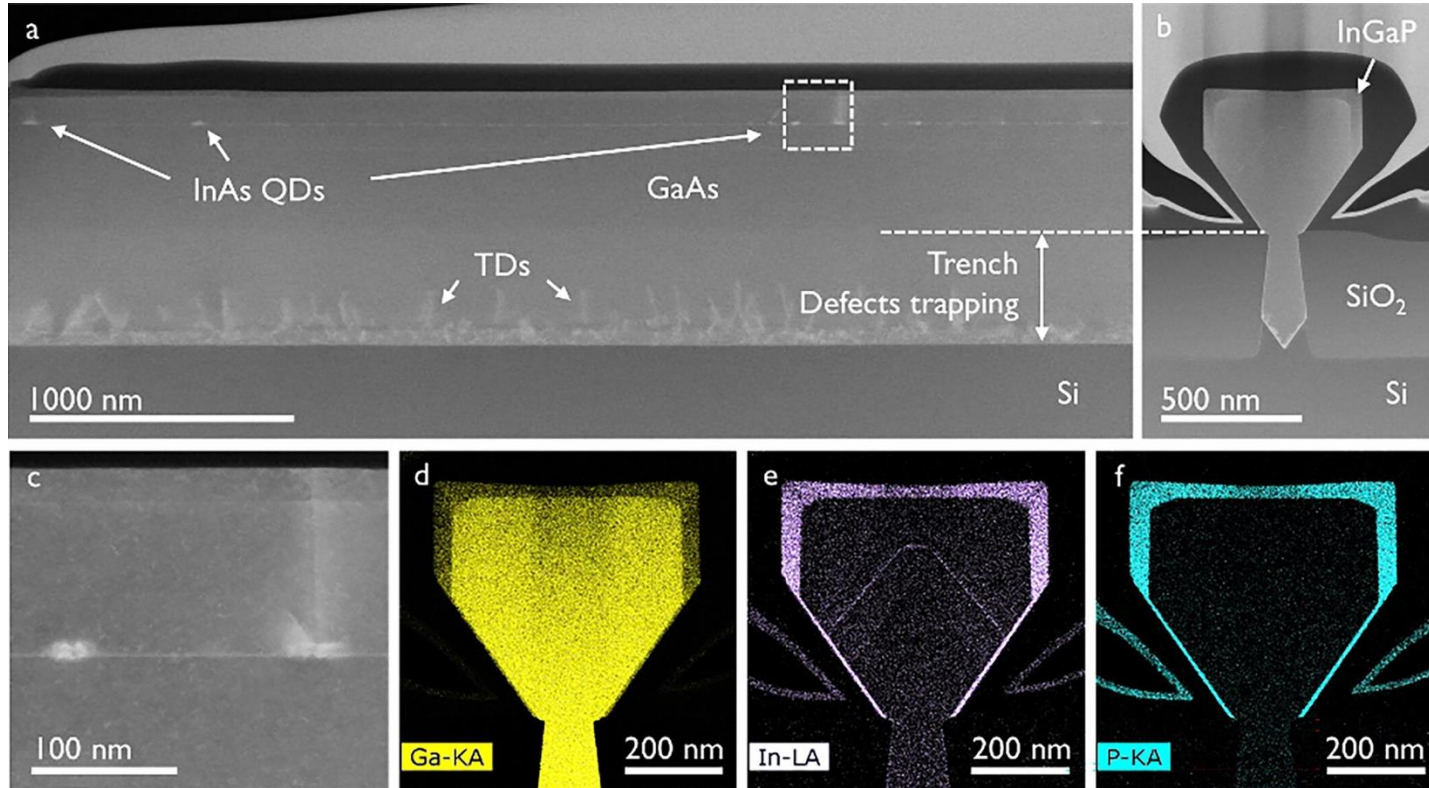
Nano-Ridge for Quantum Dot Site Control

Dimensional control allows for coupling factor (β) above 85%



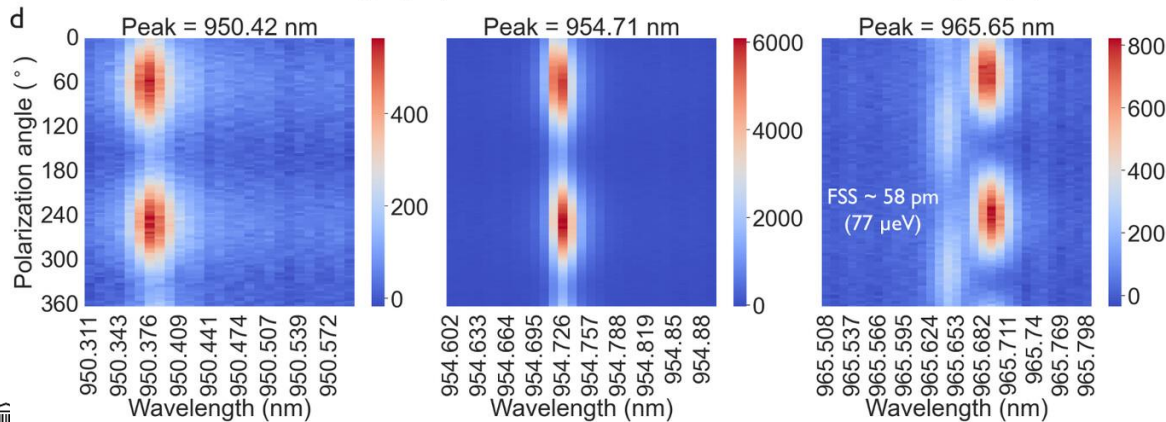
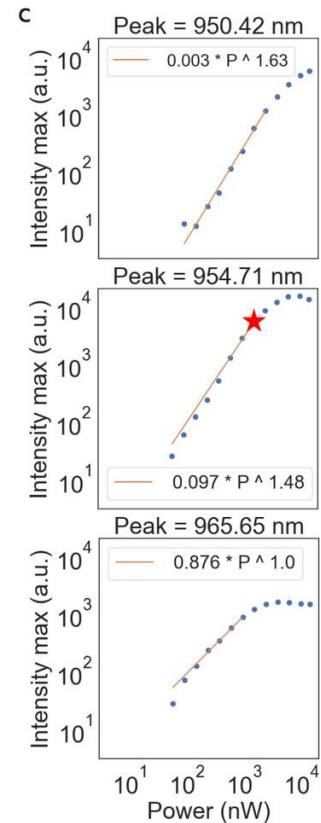
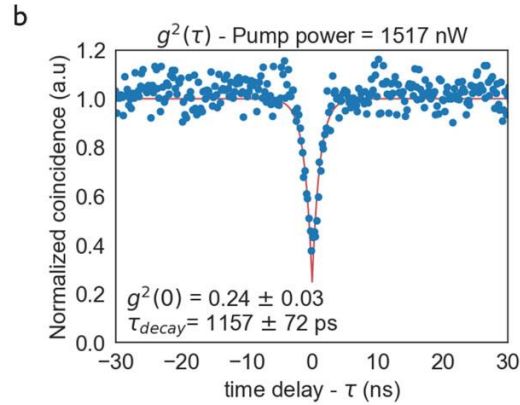
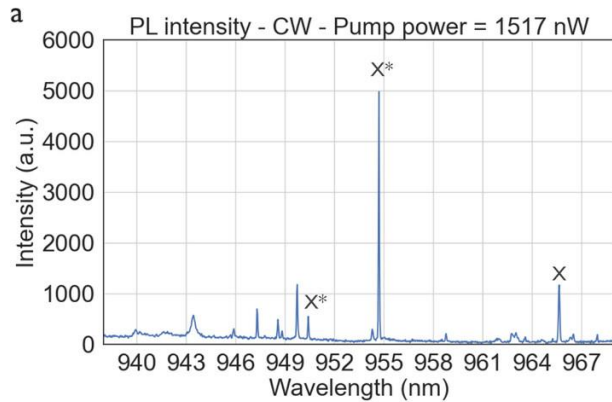
InAs QDs on 300mm Wafers

Structural analysis



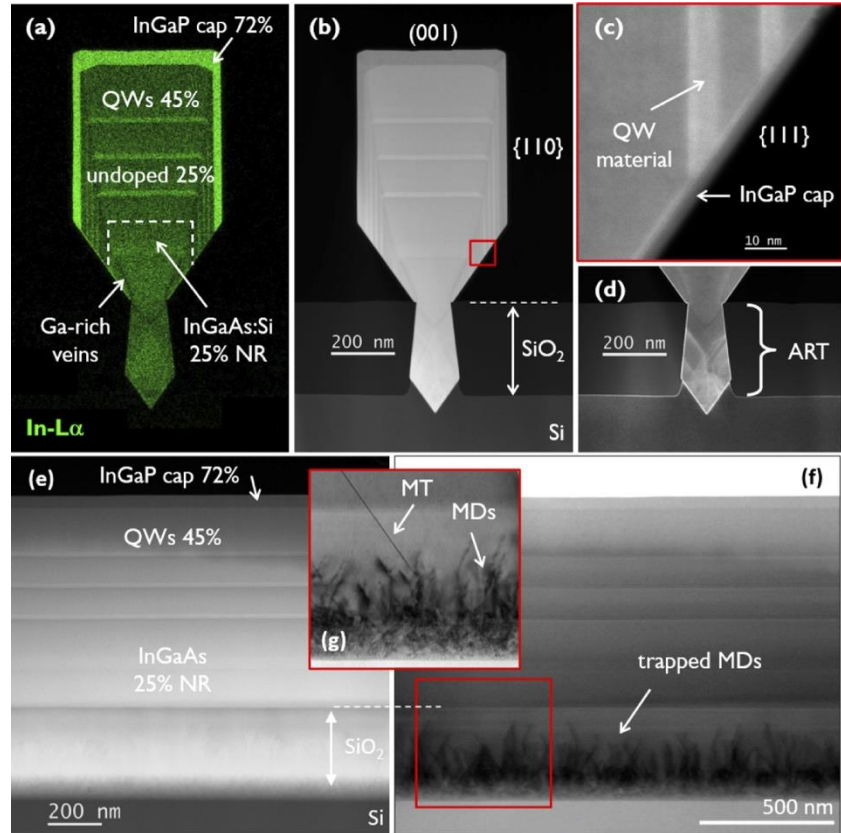
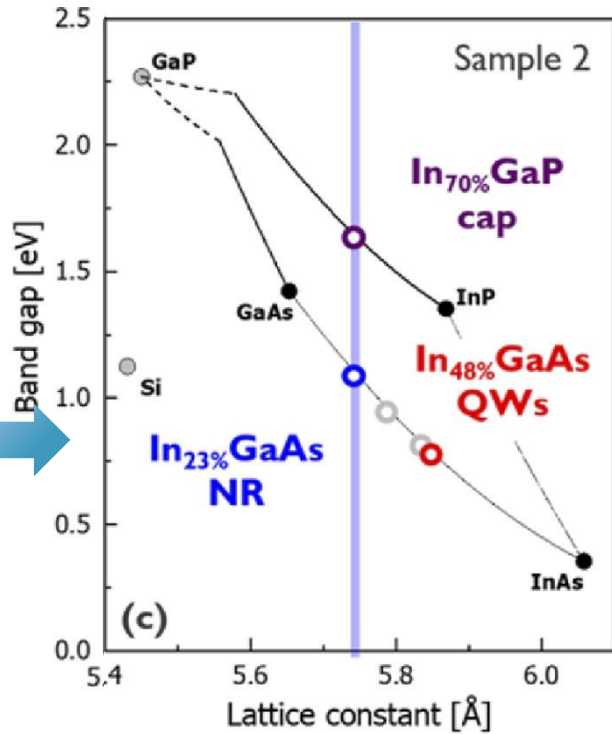
InAs QDs on 300mm Wafers

Spectral Analysis



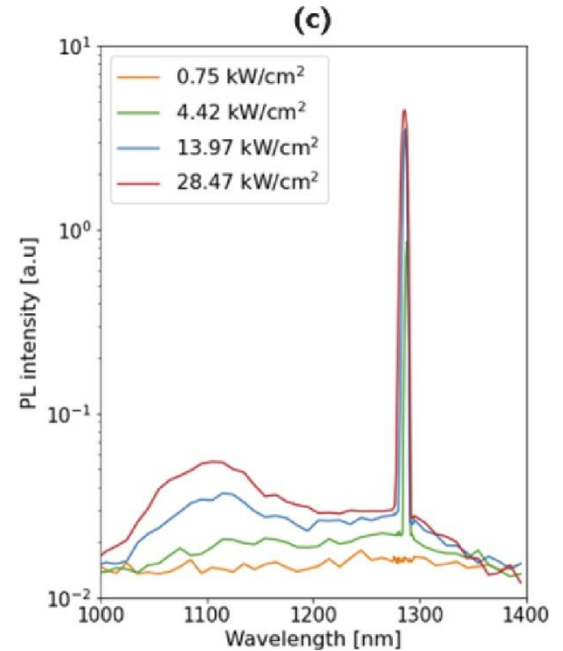
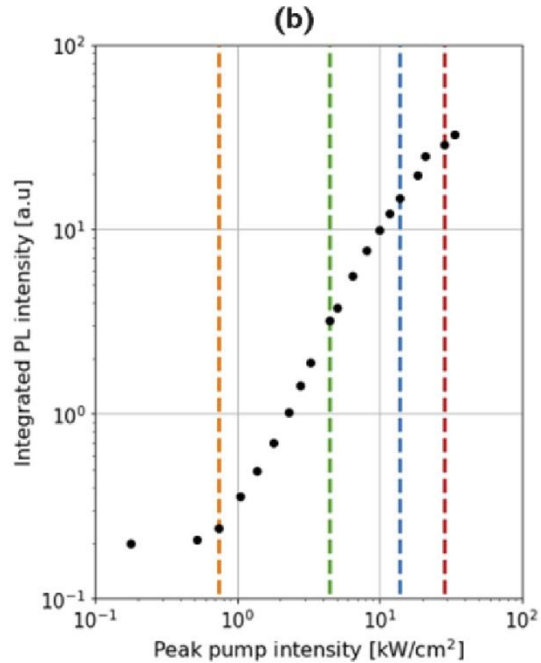
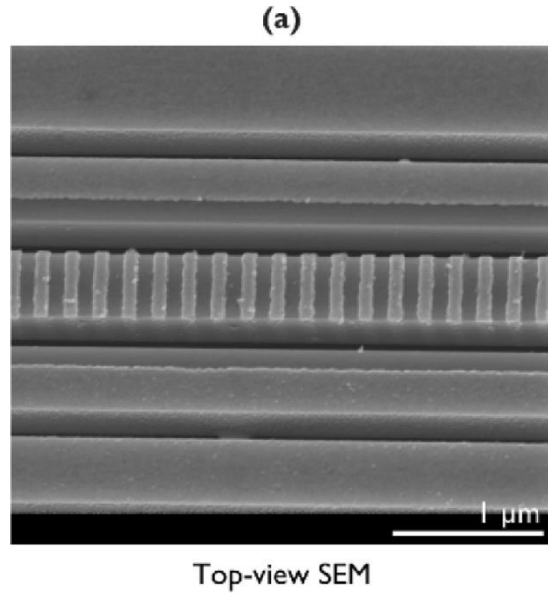
Towards O-Band Lasing

In₂₅Ga₇₅As matrix allows higher QWs with higher Indium content



Towards O-Band Lasing

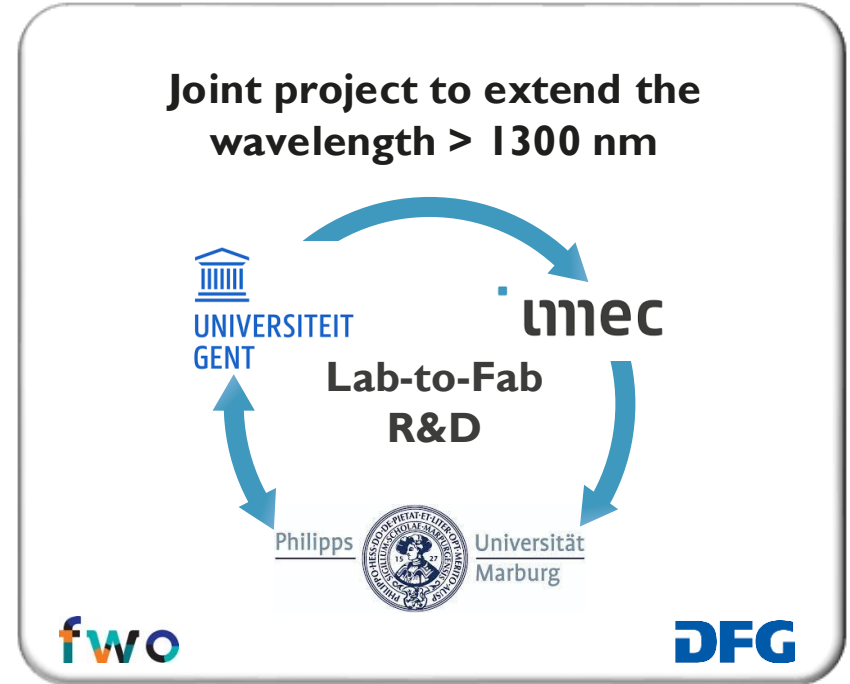
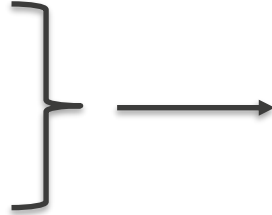
Lasing at 1280nm demonstrated



Towards O-Band Lasing

Next steps

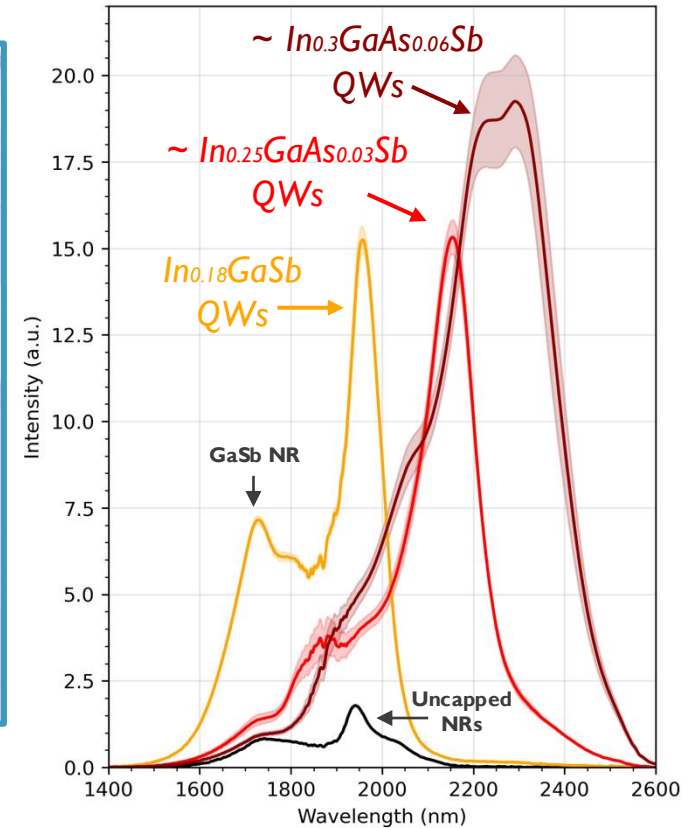
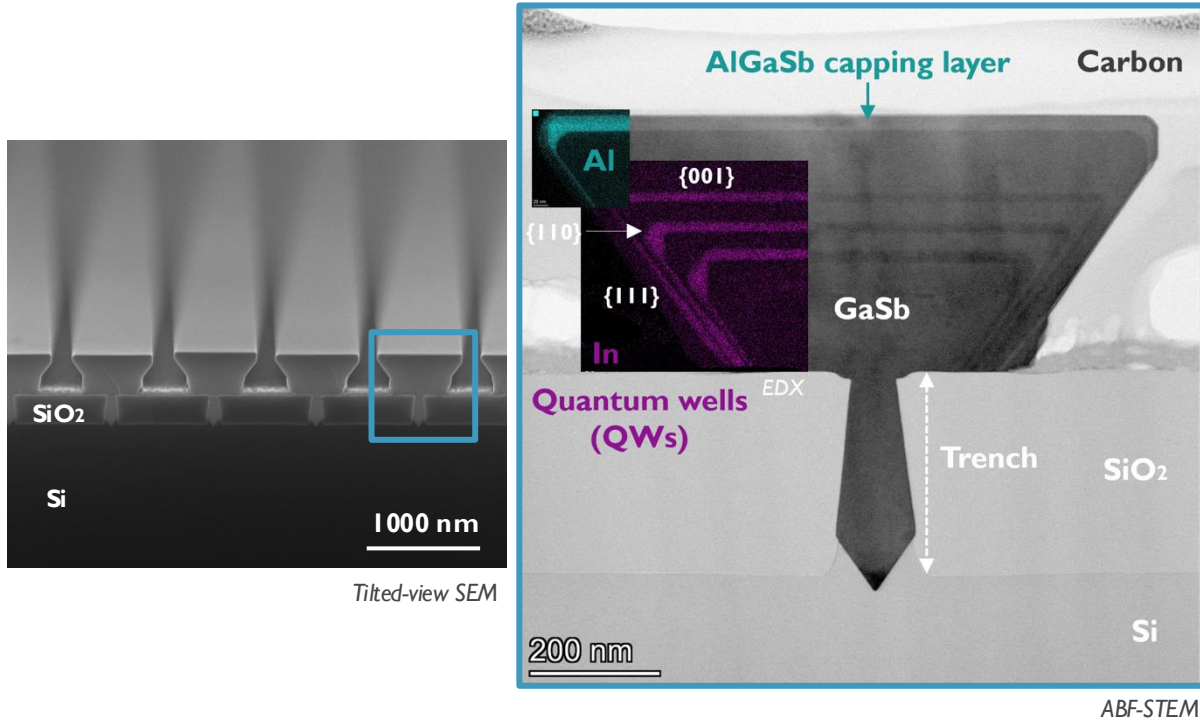
- Control of matrix composition
 - Flexible approach but challenging epitaxy
- Alternative approaches
 - Quantum dot lasers
 - W-band gain structure
 - ...



GaSb NRs with InGa(As)Sb MQWs and AlGaSb capping layer

Extend emission to the **SWIR** (1.5 – 3 μm)

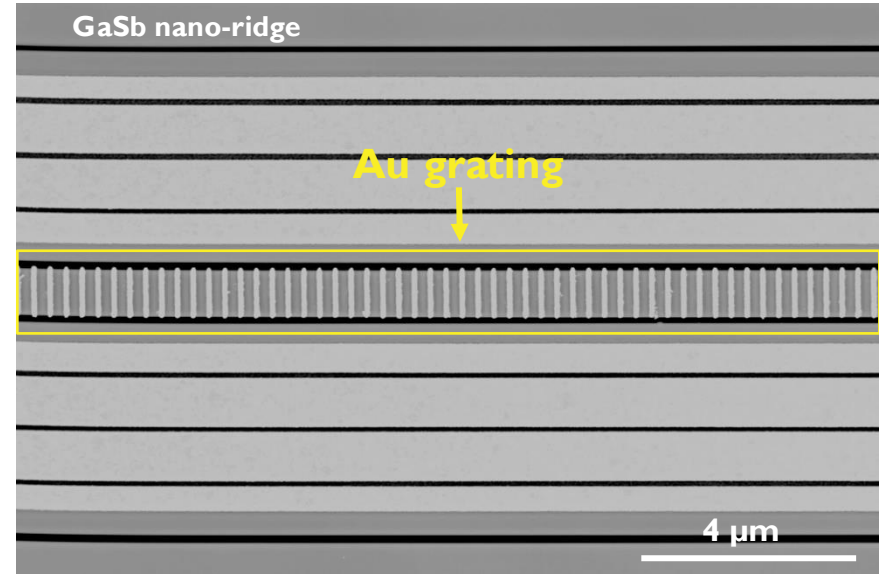
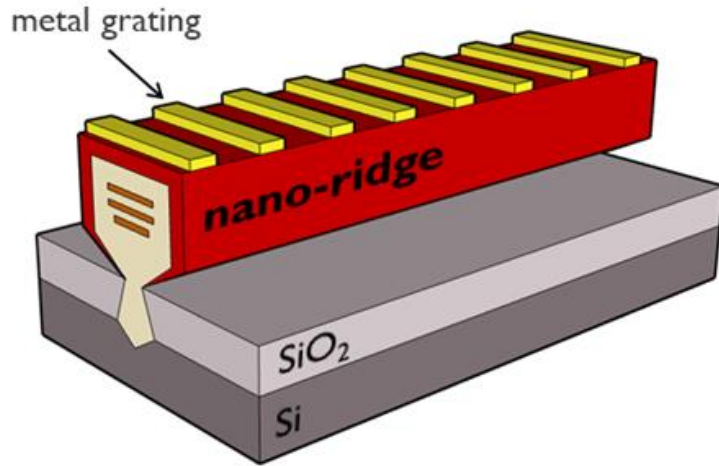
RT photoluminescence



Outlook

Realize lasing using **Distributed Feedback Grating (DFB)**

DFB grating for optical feedback



Top-view SEM

Colucci, et al (2022). Unique design approach to realize an O-band laser monolithically integrated on 300 mm Si substrate by nano-ridge engineering. *Optics Express*, 30(8), 13510-13521.

Summary & Conclusion

Related PhD Theses



European Research Council
Established by the European Commission

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Grant NARIOS Grant
agreement ID: 884963

- Y. Shi, “[GaAs nano-ridge lasers epitaxially grown on silicon](#),” Universiteit Gent. Faculteit Ingenieurswetenschappen en Architectuur, 2020.
- D. Colucci, “[Development of a quantum dot single photon source on silicon for next generation integrated quantum circuits](#),” Ghent University. Faculty of Engineering and Architecture, Ghent, Belgium, 2025.
- Z. Ouyang, “[Ultra-compact and low-threshold nano-ridge lasers epitaxially grown on silicon](#),” Ghent University. Faculty of Engineering and Architecture, Ghent, Belgium, 2025.
- A. Yiman, “[Modelling and Characterization of Electrically Pumped InGaAs/GaAs Nano -Ridge Lasers Monolithically Grown on Silicon](#)”, Ghent University. Faculty of Engineering and Architecture, Ghent, Belgium, 2026
- E. Fahmy, “Nano-Ridge Surface Emitting Lasers”, Ghent University. Faculty of Engineering and Architecture, Ghent, Belgium, 2026
- C. I. Özdemir, “[III-V photodetectors monolithically integrated on silicon for interconnect applications](#),” Ghent University. Faculty of Engineering and Architecture, Ghent, Belgium, 2024
- Hsieh, Ping-Yi, “[Reliability of Monolithic GaAs-on-Si Photonic Devices for Data Communication](#)” KULeuven, 2026 (DVT not involved)

NR2.0: Processing and preliminary device characterization

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